## FLASH MEMORY

## CMOS

## 4M ( $512 \mathrm{~K} \times 8 / 256 \mathrm{~K} \times 16$ ) BIT

## MBM29DL400TC-55/-70/-90/-12/MBM29DL400BC-55/-70/-90/-12

## - FEATURES

- Single 3.0 V read, program, and erase

Minimizes system level power requirements

- Simultaneous operations

Read-while-Erase or Read-while-Program

- Compatible with JEDEC-standard commands

Uses same software commands as E2PROMs

- Compatible with JEDEC-standard world-wide pinouts (Pin compatible with MBM29LV400TC/BC)

48-pin TSOP(I) (Package suffix: PFTN - Normal Bend Type, PFTR - Reversed Bend Type)

- Minimum 100,000 program/erase cycles
- High performance

55 ns maximum access time

- Sector erase architecture

Two 16 K byte, four 8 K bytes, two 32 K byte, and six 64 K bytes.
Any combination of sectors can be concurrently erased. Also supports full chip erase.

- Boot Code Sector Architecture

T = Top sector
B = Bottom sector

- Embedded Erase ${ }^{\text {TM }}$ Algorithms

Automatically pre-programs and erases the chip or any sector

- Embedded Program ${ }^{\top \mathrm{M}}$ Algorithms

Automatically writes and verifies data at specified address

- Data Polling and Toggle Bit feature for detection of program or erase cycle completion
- Ready/Busy output (RY/BY)

Hardware method for detection of program or erase cycle completion

- Automatic sleep mode

When addresses remain stable, automatically switch themselves to low power mode.

- Low Vcc write inhibit $\leq 2.5 \mathrm{~V}$
- Erase Suspend/Resume

Suspends the erase operation to allow a read in another sector within the same device

## MBM29DL400TC-55/-70-90/-12/MBM29DL400BC-55/-70-90/-12

(Continued)

- Sector protection

Hardware method disables any combination of sectors from program or erase operations

- Sector Protection Set function by Extended sector protection command
- Fast Programming Function by Extended Command
- Temporary sector unprotection

Temporary sector unprotection via the RESET pin.

## PACKAGE

(FPT-48P-M19)

## MBM29DL400TC-55/-70/-90/-12/MBM29DL400BC-55/-70/-90/-12

## ■ GENERAL DESCRIPTION

The MBM29DL400TC/BC are a 4M-bit, 3.0 V-only Flash memory organized as 512 K bytes of 8 bits each or 256 K words of 16 bits each. The MBM29DL400TC/BC are offered in a 48 -pin TSOP(I) package. These devices are designed to be programmed in-system with the standard system 3.0 V Vcc supply. 12.0 V Vpp and 5.0 V Vcc are not required for write or erase operations. The devices can also be reprogrammed in standard EPROM programmers.

MBM29DL400TC/BC provides simultaneous operation which can read a data while program/erase. The simultaneous operation architecture provides simultaneous operation by dividing the memory space into two banks. The device can allow a host system to program or erase in one bank, then immediately and simultaneously read from the other bank.

The standard MBM29DL400TC/BC offer access times 55 ns and 120 ns , allowing operation of high-speed microprocessors without wait states. To eliminate bus contention the devices have separate chip enable ( $\overline{\mathrm{CE}}$ ), write enable ( $\overline{\mathrm{WE}}$ ), and output enable ( $\overline{\mathrm{OE}}$ ) controls.

The MBM29DL400TC/BC are pin and command set compatible with JEDEC standard E²PROMs. Commands are written to the command register using standard microprocessor write timings. Register contents serve as input to an internal state-machine which controls the erase and programming circuitry. Write cycles also internally latch addresses and data needed for the programming and erase operations. Reading data out of the devices is similar to reading from 5.0 V and 12.0 V Flash or EPROM devices.

The MBM29DL400TC/BC are programmed by executing the program command sequence. This will invoke the Embedded Program Algorithm which is an internal algorithm that automatically times the program pulse widths and verifies proper cell margin. Typically, each sector can be programmed and verified in about 0.5 seconds. Erase is accomplished by executing the erase command sequence. This will invoke the Embedded Erase Algorithm which is an internal algorithm that automatically preprograms the array if it is not already programmed before executing the erase operation. During erase, the devices automatically time the erase pulse widths and verify proper cell margin.

A sector is typically erased and verified in 1.0 second. (If already completely preprogrammed.)
The devices also feature a sector erase architecture. The sector mode allows each sector to be erased and reprogrammed without affecting other sectors. The MBM29DL400TC/BC are erased when shipped from the factory.

The devices feature single 3.0 V power supply operation for both read and write functions. Internally generated and regulated voltages are provided for the program and erase operations. A low Vcc detector automatically inhibits write operations on the loss of power. The end of program or erase is detected by Data Polling of DQ7, by the Toggle Bit feature on $\mathrm{DQ}_{6}$, or the $\mathrm{RY} / \overline{\mathrm{BY}}$ output pin. Once the end of a program or erase cycle has been completed, the devices internally reset to the read mode.

Fujitsu's Flash technology combines years of EPROM and E2PROM experience to produce the highest levels of quality, reliability, and cost effectiveness. The MBM29DL400TC/BC memories electrically erase the entire chip or all bits within a sector simultaneously via Fowler-Nordhiem tunneling. The bytes/words are programmed one byte/word at a time using the EPROM programming mechanism of hot electron injection.

## MBM29DL400TC-55/-70-90/-12/MBM29DL400BC-55/-70-90/-12

## FLEXIBLE SECTOR-ERASE ARCHITECTURE

- Two 16 K bytes, four 8 K bytes, two 32 K bytes, and six 64 K bytes
- Individual-sector, multiple-sector, or bulk-erase capability
- Individual or multiple-sector protection is user definable.


MBM29DL400TC Sector Architecture
(X8)
(X16)


MBM29DL400BC Sector Architecture

## MBM29DL400TC-55/-70/-90/-12/MBM29DL400BC-55/-70/-90/-12

## PRODUCT LINE UP

| Part No. |  | MBM29DL400TC/MBM29DL400BC |  |  |  |
| :--- | :--- | :--- | :--- | :--- | :--- |
| Ordering Part No. | $\mathrm{V}_{\mathrm{cc}}=3.3 \mathrm{~V} \underset{-0.3 \mathrm{~V}}{+0.3 \mathrm{~V}}$ | -55 | -70 | - | - |
|  | $\mathrm{V}_{\mathrm{cc}}=3.0 \mathrm{~V} \underset{-0.3 \mathrm{~V}}{+0.6 \mathrm{~V}}$ | - | - | -90 | -12 |
|  | 55 | 70 | 90 | 120 |  |
| Max. $\overline{\mathrm{CE}}$ Access Time (ns) | 55 | 70 | 90 | 120 |  |
| Max. $\overline{\mathrm{OE}}$ Access Time (ns) | 30 | 30 | 35 | 50 |  |

## BLOCK DIAGRAM



## MBM29DL400TC-55/-70/-90/-12/MBM29DL400BC-55/-70/-90/-12

## CONNECTION DIAGRAMS

TSOP(I)


FPT-48P-M19

| $\mathrm{A}_{1}$ | 24 | (Marking Side) | 25 | $\square A_{0}$ |
| :---: | :---: | :---: | :---: | :---: |
| $\mathrm{A}_{2}$ | 23 |  | 26 | $\square \overline{C E}$ |
| A $_{3} \square$ | 22 |  | 27 | $\square \mathrm{Vss}$ |
| $\mathrm{A}_{4}$ | 21 |  | 28 | $\square$ OE |
| $\mathrm{A}_{5}$ | 20 |  | 29 | $\square \mathrm{DQ}_{0}$ |
| $\mathrm{A}_{6}$ | 19 |  | 30 | $\checkmark$ DQ8 |
| A7 | 18 |  | 31 | $\square \mathrm{DQ}_{1}$ |
| $\mathrm{A}_{17}$ | 17 |  | 32 | $\square$ DQ9 |
| N.C. $\square$ | 16 |  | 33 | $\checkmark \mathrm{DQ}_{2}$ |
| RY/BY $\square$ | 15 |  | 34 | $\square \mathrm{DQ}_{10}$ |
| N.C. | 14 |  | 35 | DQ3 |
| N.C. $\square$ | 13 | MBM29DL400TC/MBM29DL400BC | 36 | DQ11 |
| RESET | 12 | Reverse Pinout | 37 | $\square \mathrm{Vcc}$ |
| WE | 11 |  | 38 | $\square \mathrm{DQ}_{4}$ |
| N.C. $\square$ | 10 |  | 39 | $\square \mathrm{DQ}_{12}$ |
| N.C. $\square$ | 9 |  | 40 | $\square \mathrm{DQ}_{5}$ |
| $\mathrm{A}_{8}$ | 8 |  | 41 | $\mathrm{DQ}_{13}$ |
| А9 | 7 |  | 42 | $\mathrm{DQ}_{6}$ |
| $\mathrm{A}_{10}$ | 6 |  | 43 | $\mathrm{DQ}_{14}$ |
| $\mathrm{A}_{11}$ | 5 |  | 44 | $\square \mathrm{DQ}_{7}$ |
| $\mathrm{A}_{12}$ | 4 |  | 45 | $\square$ DQ15/A-1 |
| $\mathrm{A}_{13}$ | 3 |  | 46 | Vss |
| $\mathrm{A}_{14}$ | 2 |  | 47 | BYTE |
| $\mathrm{A}_{15} \square$ | 1 |  | 48 | $\square \mathrm{A}_{16}$ |

FPT-48P-M20

## MBM29DL400TC-55/-70/-90/-12/MBM29DL400BC-55/-70/-90/-12

## LOGIC SYMBOL



Table 1 MBM29DL400TC/BC Pin Configuration

| Pin | Function |
| :---: | :--- |
| $\mathrm{A}_{-1}, \mathrm{~A}_{0}$ to $\mathrm{A}_{17}$ | Address Inputs |
| $\mathrm{DQ}_{0}$ to $\mathrm{DQ}_{15}$ | Data Inputs/Outputs |
| $\overline{\mathrm{CE}}$ | Chip Enable |
| $\overline{\mathrm{OE}}$ | Output Enable |
| $\overline{\mathrm{WE}}$ | Write Enable |
| RY/险 | Ready/Busy Output |
| $\overline{\mathrm{RESET}}$ | Hardware Reset Pin/Temporary Sector <br> Unprotection |
| $\overline{\mathrm{BYTE}}$ | Selects 8-bit or 16-bit mode |
| N.C. | No Internal Connection |
| Vss | Device Ground |
| Vcc | Device Power Supply |

## MBM29DL400TC-55/-70/-90/-12/MBM29DL400BC-55/-70/-90/-12

Table 2 MBM29DL400TC/BC User Bus Operations ( $\overline{\text { BYTE }}=\mathrm{V}_{\boldsymbol{H}}$ )

| Operation | $\overline{\text { CE }}$ | $\overline{\mathrm{OE}}$ | $\overline{W E}$ | A 0 | $\mathrm{A}_{1}$ | $\mathrm{A}_{6}$ | A9 | DQ ${ }_{0}$ to DQ15 | RESET |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Auto-Select Manufacturer Code (1) | L | L | H | L | L | L | $V_{10}$ | Code | H |
| Auto-Select Device Code (1) | L | L | H | H | L | L | VID | Code | H |
| Read (3) | L | L | H | A0 | $\mathrm{A}_{1}$ | $\mathrm{A}_{6}$ | A9 | Dout | H |
| Standby | H | X | X | X | X | X | X | HIGH-Z | H |
| Output Disable | L | H | H | X | X | X | X | HIGH-Z | H |
| Write (Program/Erase) | L | H | L | $\mathrm{A}_{0}$ | $\mathrm{A}_{1}$ | $\mathrm{A}_{6}$ | A9 | Din | H |
| Enable Sector Protection (2), (4) | L | VID | Ъ | L | H | L | VID | X | H |
| Verify Sector Protection (2), (4) | L | L | H | L | H | L | VID | Code | H |
| Temporary Sector Unprotection (5) | X | X | X | X | X | X | X | X | VID |
| Reset (Hardware)/Standby | X | X | X | X | X | X | x | HIGH-Z | L |

Table 3 MBM29DL400TC/BC User Bus Operations ( $\overline{\mathrm{BYTE}}=\mathrm{V}_{\mathrm{IL}}$ )

| Operation | $\overline{C E}$ | $\overline{\mathrm{OE}}$ | $\overline{\text { WE }}$ | $\overline{\mathbf{D Q}_{\mathbf{1}-1}}$ | A0 | $\mathrm{A}_{1}$ | A6 | A9 | DQ ${ }_{0}$ to $\mathrm{DQ}_{7}$ | RESET |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Auto-Select Manufacturer Code (1) | L | L | H | L | L | L | L | VID | Code | H |
| Auto-Select Device Code (1) | L | L | H | L | H | L | L | VID | Code | H |
| Read (3) | L | L | H | A-1 | A0 | $\mathrm{A}_{1}$ | $\mathrm{A}_{6}$ | A9 | Dout | H |
| Standby | H | X | X | X | X | X | X | X | HIGH-Z | H |
| Output Disable | L | H | H | X | X | X | X | X | HIGH-Z | H |
| Write (Program/Erase) | L | H | L | A-1 | $\mathrm{A}_{0}$ | $\mathrm{A}_{1}$ | $\mathrm{A}_{6}$ | A9 | Din | H |
| Enable Sector Protection (2), (4) | L | VID | Ъ | L | L | H | L | VID | X | H |
| Verify Sector Protection (2), (4) | L | L | H | L | L | H | L | VID | Code | H |
| Temporary Sector Unprotection (5) | X | X | X | X | X | X | X | X | X | VID |
| Reset (Hardware)/Standby | X | X | X | X | X | X | X | X | HIGH-Z | L |

Legend: $L=V_{I L}, H=V_{I H}, X=V_{I L}$ or $V_{I H}, ~ \smile=$ Pulse input. See DC Characteristics for voltage levels.
Notes: 1. Manufacturer and device codes may also be accessed via a command register write sequence. See Table 8.
2. Refer to the section on Sector Protection.
3. WE can be $\mathrm{V}_{\mathrm{IL}}$ if OE is $\mathrm{V}_{\mathrm{L}}, \overline{\mathrm{OE}}$ at $\mathrm{V}_{\mathrm{H}}$ initiates the write operations.
4. $V c c=3.3 \mathrm{~V} \pm 10 \%$
5. It is also used for the extended sector protection.

## MBM29DL400TC-55/-70/-90/-12/MBM29DL400BC-55/-70-90/-12

## ORDERING INFORMATION

## Standard Products

Fujitsu standard products are available in several packages. The order number is formed by a combination of:


## MBM29DL400TC-55/-70-90/-12/MBM29DL400BC-55/-70/-90-12

## FUNCTIONAL DESCRIPTION

## Simultaneous Operation

MBM29DL400TC/BC have feature, which is capability of reading data from one bank of memory while a program or erase operation is in progress in the other bank of memory (simultaneous operation), in addition to the conventional features (read, program, erase, erase-suspend read, and erase-suspend program). The bank selection can be selected by bank address ( $\mathrm{A}_{16}, \mathrm{~A}_{17}$ ) with zero latency.
The MBM29DL400TC/BC have two banks which contain Bank 1 (16KB, 32KB, 8KB, 8KB, 8KB, $8 \mathrm{~KB}, 32 \mathrm{~KB}$, and 16 KB ) and Bank 2 ( $64 \mathrm{~KB} \times$ six sectors).
The simultaneous operation can not execute multi-function mode in the same bank. Table 4 shows combination to be possible for simultaneous operation.

Table 4 Simultaneous Operation

| Case | Bank 1 Status | Bank 2 Status |
| :---: | :---: | :---: |
| 1 | Read mode | Read mode |
| 2 | Read mode | Autoselect mode |
| 3 | Read mode | Program mode |
| 4 | Read mode | Erase mode |
| 5 | Autoselect mode | Read mode |
| 6 | Program mode | Read mode |
| 7 | Erase mode * | Read mode |

*: An erase operation may also be supended to read from or program to a sector not being erased.

## Read Mode

The MBM29DL400TC/BC have two control functions which must be satisfied in order to obtain data at the outputs. $\overline{\mathrm{CE}}$ is the power control and should be used for a device selection. $\overline{\mathrm{OE}}$ is the output control and should be used to gate data to the output pins if a device is selected.
Address access time ( $\mathrm{t}_{\mathrm{Acc}}$ ) is equal to the delay from stable addresses to valid output data. The chip enable access time (tce) is the delay from stable addresses and stable $\overline{\mathrm{CE}}$ to valid data at the output pins. The output enable access time is the delay from the falling edge of $\overline{\mathrm{OE}}$ to valid data at the output pins. (Assuming the addresses have been stable for at least tacc-toe time.) When reading out a data without changing addresses after power-up, it is necessary to input hardware reset or to change $\overline{\mathrm{CE}}$ pin from " H " or "L"

## Standby Mode

There are two ways to implement the standby mode on the MBM29DL400TC/BC devices, one using both the $\overline{\mathrm{CE}}$ and $\overline{\mathrm{RESET}}$ pins; the other via the $\overline{\text { RESET pin only. }}$
When using both pins, a CMOS standby mode is achieved with $\overline{\mathrm{CE}}$ and $\overline{\operatorname{RESET}}$ inputs both held at $\mathrm{V} c \mathrm{~m} \pm 0.3 \mathrm{~V}$. Under this condition the current consumed is less than $5 \mu \mathrm{~A}$ max. During Embedded Algorithm operation, Vcc active current ( Iccc ) is required even $\overline{\mathrm{CE}}=$ " H ". The device can be read with standard access time (tcE) from either of these standby modes.

When using the RESET pin only, a CMOS standby mode is achieved with RESET input held at $\mathrm{V}_{\mathrm{ss}} \pm 0.3 \mathrm{~V}$ ( $\overline{\mathrm{CE}}$ $=$ " H " or "L"). Under this condition the current is consumed is less than $5 \mu \mathrm{~A}$ max. Once the RESET pin is taken high, the device requires $\mathrm{trн}^{\boldsymbol{r}}$ of wake up time before outputs are valid for read access.

In the standby mode the outputs are in the high impedance state, independent of the $\overline{\mathrm{OE}}$ input.

## MBM29DL400TC-55/-70/-90/-12/MBM29DL400BC-55/-70/-90/-12

## Automatic Sleep Mode

There is a function called automatic sleep mode to restrain power consumption during read-out of MBM29DL400TC/BC data. This mode can be used effectively with an application requested low power consumption such as handy terminals.

To activate this mode, MBM29DL400TC/BC automatically switch themselves to low power mode when MBM29DL400TC/BC addresses remain stably during access fine of 150 ns . It is not necessary to control $\overline{\mathrm{CE}}$, $\overline{\mathrm{WE}}$, and $\overline{\mathrm{OE}}$ on the mode. Under the mode, the current consumed is typically $1 \mu \mathrm{~A}$ (CMOS Level).
During simultaneous operation, $\mathrm{V}_{\mathrm{cc}}$ active current (lccz) is required.
Since the data are latched during this mode, the data are read-out continuously. If the addresses are changed, the mode is canceled automatically and MBM29DL400TC/BC read-out the data for changed addresses.

## Output Disable

With the $\overline{\mathrm{OE}}$ input at a logic high level $\left(\mathrm{V}_{\boldsymbol{H}}\right)$, output from the devices are disabled. This will cause the output pins to be in a high impedance state.

## Autoselect

The autoselect mode allows the reading out of a binary code from the devices and will identify its manufacturer and type. This mode is intended for use by programming equipment for the purpose of automatically matching the devices to be programmed with its corresponding programming algorithm. This mode is functional over the entire temperature range of the devices.

To activate this mode, the programming equipment must force $\mathrm{V}_{\mathrm{ID}}(11.5 \mathrm{~V}$ to 12.5 V ) on address pin Ag. Two identifier bytes may then be sequenced from the devices outputs by toggling address $A_{0}$ from $\mathrm{V}_{\mathrm{IL}}$ to $\mathrm{V}_{\text {IH. }}$. All addresses are DON'T CARES except $\mathrm{A}_{0}, \mathrm{~A}_{1}$, and $\mathrm{A}_{6}\left(\mathrm{~A}_{-1}\right)$. (See Tables 2 and 3.)

The manufacturer and device codes may also be read via the command register, for instances when the MBM29DL400TC/BC are erased or programmed in a system without access to high voltage on the As pin. The command sequence is illustrated in Table 8. (Refer to Autoselect Command section.)
Word $0\left(\mathrm{~A}_{0}=\mathrm{V}_{L}\right)$ represents the manufacturer's code $($ Fujitsu $=04 \mathrm{H})$ and word $1\left(\mathrm{~A}_{0}=\mathrm{V}_{H}\right)$ represents the device identifier code (MBM29DL400TC $=0 \mathrm{CH}$ and MBM29DL400BC $=0 \mathrm{FH}$ for $\times 8$ mode; MBM29DL400TC $=220 \mathrm{CH}$ and MBM29DL400BC $=220 \mathrm{FH}$ for $\times 16$ mode). These two bytes/words are given in the tables 5.1 and 5.2. All identifiers for manufactures and device will exhibit odd parity with DQ7 defined as the parity bit. In order to read the proper device codes when executing the autoselect, $\mathrm{A}_{1}$ must be VIL. (See Tables 5.1 and 5.2.)

In case of applying Vid on As, since both Bank 1 and Bank 2 enters Autoselect mode, the simultenous operation can not be executed.

## MBM29DL400TC-55/-70/-90/-12/MBM29DL400BC-55/-70-90/-12

Table 5.1 MBM29DL400TC/BC Sector Protection Verify Autoselect Codes

| Type |  |  | $\mathrm{A}_{12}$ to $\mathrm{A}_{17}$ | A6 | $\mathrm{A}_{1}$ | A0 | A-1 ${ }^{+1}$ | Code (HEX) |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Manufacture's Code |  |  | X | VIL | VIL | VIL | VIL | 04H |
| Device Code | MBM29DL400TC | Byte | X | VIL | VIL | $\mathrm{V}_{\text {IH }}$ | VIL | OCH |
|  |  | Word |  |  |  |  | X | 220CH |
|  | MBM29DL400BC | Byte | X | VIL | VIL | VIH | VIL | OFH |
|  |  | Word |  |  |  |  | X | 220FH |
| Sector Protection |  |  | Sector Addresses | VII | VIH | VIL | VIL | $01 \mathrm{H}^{*}$ |

*1: A-1 is for Byte mode.
*2: Outputs 01 H at protected sector addresses and outputs 00 H at unprotected sector addresses.
Table 5.2 Expanded Autoselect Code Table

| Type |  |  | Code | $\mathrm{DQ}_{15}$ | $\mathrm{DQ}_{14}$ | $\mathrm{DQ}_{13}$ | $\mathrm{DQ}_{12}$ | DQ ${ }_{11}$ | DQ 10 | DQ ${ }_{\text {a }}$ | DQ ${ }_{8}$ | DQ ${ }_{7}$ | DQ | DQ ${ }_{5}$ | DQ ${ }_{4}$ | $\mathrm{DQ}_{3}$ | $\mathrm{DQ}_{2}$ | DQ ${ }_{1}$ | DQ 0 |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Manufacturer's Code |  |  | 04H | A. $/ 0$ | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 1 | 0 | 0 |
| Device Code | MBM29DL400TC | (B) | 0CH | A-1 | HI-Z | HI-Z | HI-Z | HI-Z | HI-Z | HI-Z | HI-Z | 0 | 0 | 0 | 0 | 1 | 1 | 0 | 0 |
|  |  | (W) | 220 CH | 0 | 0 | 1 | 0 | 0 | 0 | 1 | 0 | 0 | 0 | 0 | 0 | 1 | 1 | 0 | 0 |
|  | MBM29DL400BC | (B) | OFH | A-1 | HI-Z | HI-Z | HI-Z | HI-Z | HI-Z | HI-Z | HI-Z | 0 | 0 | 0 | 0 | 1 | 1 | 1 | 1 |
|  |  | (W) | 220FH | 0 | 0 | 1 | 0 | 0 | 0 | 1 | 0 | 0 | 0 | 0 | 0 | 1 | 1 | 1 | 1 |
| Sector Protection |  |  | 01H | A. $1 / 0$ | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 1 |

(B): Byte mode
(W): Word mode

## MBM29DL400TC-55/-70/-90/-12/MBM29DL400BC-55/-70/-90/-12

## Write

Device erasure and programming are accomplished via the command register. The contents of the register serve as inputs to the internal state machine. The state machine outputs dictate the function of the device.

The command register itself does not occupy any addressable memory location. The register is a latch used to store the commands, along with the address and data information needed to execute the command. The command register is written by bringing $\overline{\mathrm{WE}}$ to $\mathrm{V}_{\mathrm{IL}}$, while $\overline{\mathrm{CE}}$ is at $\mathrm{V}_{\mathrm{IL}}$ and $\overline{\mathrm{OE}}$ is at $\mathrm{V}_{\mathrm{IH}}$. Addresses are latched on the falling edge of $\overline{W E}$ or $\overline{\mathrm{CE}}$, whichever happens later; while data is latched on the rising edge of $\overline{\mathrm{WE}}$ or $\overline{\mathrm{CE}}$, whichever happens first. Standard microprocessor write timings are used.

Refer to AC Write Characteristics and the Erase/Programming Waveforms for specific timing parameters.

## Sector Protection

The MBM29DL400TC/BC feature hardware sector protection. This feature will disable both program and erase operations in any number of sectors ( 0 through 13). The sector protection feature is enabled using programming equipment at the user's site. The devices are shipped with all sectors unprotected. Alternatively, Fujitsu may program and protect sectors in the factory prior to shiping the device.

To activate this mode, the programming equipment must force $\mathrm{V}_{\mathrm{ID}}$ on address pin $\mathrm{A}_{9}$ and control pin $\overline{\mathrm{OE}}$, (suggest $\left.\mathrm{V}_{10}=11.5 \mathrm{~V}\right), \overline{\mathrm{CE}}=\mathrm{V}_{\mathrm{IL}}$, and $\mathrm{A}_{0}=\mathrm{A}_{6}=\mathrm{V}_{\mathrm{L}}, \mathrm{A}_{1}=\mathrm{V}_{1 H}$. The sector addresses ( $\mathrm{A}_{17}, \mathrm{~A}_{16}, \mathrm{~A}_{15}, \mathrm{~A}_{14}, \mathrm{~A}_{13}$, and $\mathrm{A}_{12}$ ) should be set to the sector to be protected. Tables 6 and 7 define the sector address for each of the forteen (14) individual sectors. Programming of the protection circuitry begins on the falling edge of the WE pulse and is terminated with the rising edge of the same. Sector addresses must be held constant during the WE pulse. See Figures 16 and 25 for sector protection waveforms and algorithm.

To verify programming of the protection circuitry, the programming equipment must force $\mathrm{V}_{10}$ on address pin $\mathrm{A}_{9}$ with $\overline{\mathrm{CE}}$ and $\overline{\mathrm{OE}}$ at $\mathrm{V}_{I L}$ and $\overline{\mathrm{WE}}$ at $\mathrm{V}_{1 \text {. }}$. Scanning the sector addresses ( $\mathrm{A}_{17}, \mathrm{~A}_{16}, \mathrm{~A}_{15}, \mathrm{~A}_{14}, \mathrm{~A}_{13}$, and $\mathrm{A}_{12}$ ) while ( $\mathrm{A}_{6}$, $\left.A_{1}, A_{0}\right)=(0,1,0)$ will produce a logical "1" code at device output $D Q_{0}$ for a protected sector. Otherwise the devices will read 00 H for unprotected sector. In this mode, the lower order addresses, except for $A_{0}, A_{1}$, and $A_{6}$ are DON'T CARES. Address locations with $\mathrm{A}_{1}=\mathrm{V}_{\mathrm{I}}$ are reserved for Autoselect manufacturer and device codes. A-1 requires to apply to VIL on byte mode.

It is also possible to determine if a sector is protected in the system by writing an Autoselect command. Performing a read operation at the address location $\mathrm{XX02H}$, where the higher order addresses ( $\mathrm{A}_{17}, \mathrm{~A}_{16}, \mathrm{~A}_{15}$, $\mathrm{A}_{14}$, $\mathrm{A}_{13}$, and $\mathrm{A}_{12}$ ) are the desired sector address will produce a logical "1" at DQo for a protected sector. See Tables 5.1 and 5.2 for Autoselect codes.

## Temporary Sector Unprotection

This feature allows temporary unprotection of previously protected sectors of the MBM29DL400TC/BC devices in order to change data. The Sector Unprotection mode is activated by setting the RESET pin to high voltage ( 12 V ). During this mode, formerly protected sectors can be programmed or erased by selecting the sector addresses. Once the 12 V is taken away from the $\overline{\text { RESET }}$ pin, all the previously protected sectors will be protected again. See Figures 17 and 26.

## MBM29DL400TC-55/-70/-90/-12/MBM29DL400BC-55/-70/-90/-12

## RESET

## Hardware Reset

The MBM29DL400TC/BC devices may be reset by driving the RESET pin to VIL. The RESET pin has a pulse requirement and has to be kept low ( $\mathrm{V}_{\mathrm{L}}$ ) for at least 500 ns in order to properly reset the internal state machine. Any operation in the process of being executed will be terminated and the internal state machine will be reset to the read mode $20 \mu s$ after the $\overline{\operatorname{RESET}}$ pin is driven low. Furthermore, once the $\overline{\text { RESET }}$ pin goes high, the devices require an additional try before it will allow read access. When the RESET pin is low, the devices will be in the standby mode for the duration of the pulse and all the data output pins will be tri-stated. If a hardware reset occurs during a program or erase operation, the data at that particular location will be corrupted. Please note that the RY/ $\overline{B Y}$ output signal should be ignored during the $\overline{\operatorname{RESET}}$ pulse. See Figure 12 for the timing diagram. Refer to Temporary Sector Unprotection for additional functionality.

## MBM29DL400TC-55/-70/-90/-12/MBM29DL400BC-55/-70/-90/-12

Table 6 Sector Address Tables (MBM29DL400TC)

| Bank | Sector | Sector Address |  |  |  |  |  | Sector Size (K bytes/ K words) | $\begin{gathered} \text { (X 8) } \\ \text { Address Range } \end{gathered}$ | (X 16) <br> Address Range |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | BankAddress |  | A15 | $\mathrm{A}_{14}$ | $\mathrm{A}_{13}$ | $\mathrm{A}_{12}$ |  |  |  |
|  |  | A 17 | A16 |  |  |  |  |  |  |  |
| Bank 2 | SAO | 0 | 0 | 0 | X | X | X | 64/32 | 00000H to 0FFFFFH | 00000H to 07FFFH |
|  | SA1 | 0 | 0 | 1 | X | X | X | 64/32 | 10000 H to 1FFFFH | 08000H to OFFFFH |
|  | SA2 | 0 | 1 | 0 | X | X | X | 64/32 | 20000 H to 2FFFFH | 10000 H to 17FFFH |
|  | SA3 | 0 | 1 | 1 | X | X | X | 64/32 | 30000 H to 3FFFFH | 18000 H to 1FFFFH |
|  | SA4 | 1 | 0 | 0 | X | X | X | 64/32 | 40000 H to 4FFFFH | 20000H to 27FFFH |
|  | SA5 | 1 | 0 | 1 | X | X | X | 64/32 | 50000 H to 5FFFFH | 28000H to 2FFFFH |
| Bank 1 | SA6 | 1 | 1 | 0 | 0 | 0 | X | 16/8 | 60000 H to 63FFFH | 30000 H to 31FFFH |
|  | SA7 | 1 | 1 | 0 | $\begin{aligned} & 0 \\ & \hline 1 \end{aligned}$ | $\begin{aligned} & 1 \\ & 0 \end{aligned}$ | X | 32/16 | 64000H to 67FFFH 68000 H to 6 BFFFH | 32000 H to 33 FFFH <br> 34000 H to 35 FFFH |
|  | SA8 | 1 | 1 | 0 | 1 | 1 | 0 | 8/4 | 6C000H to 6DFFFH | 36000 H to 36FFFH |
|  | SA9 | 1 | 1 | 0 | 1 | 1 | 1 | 8/4 | 6E000H to 6FFFFH | 37000 H to 37FFFH |
|  | SA10 | 1 | 1 | 1 | 0 | 0 | 0 | 8/4 | 70000H to 71FFFH | 38000 H to 38FFFH |
|  | SA11 | 1 | 1 | 1 | 0 | 0 | 1 | 8/4 | 72000H to 73FFFH | 39000 H to 39FFFH |
|  | SA12 | 1 | 1 | 1 | $\begin{aligned} & 0 \\ & \hline 1 \end{aligned}$ | 1 | X | 32/16 | 74000H to 77FFFH <br> 78000 H to 7 BFFFH | 3A000H to 3BFFFH 3 COOOH to 3DFFFH |
|  | SA13 | 1 | 1 | 1 | 1 | 1 | X | 16/8 | 7C000H to 7FFFFH | 3E000H to 3FFFFH |

Note: The address range is $A_{17}: \mathrm{A}_{-1}$ if in byte mode $\left(\overline{\mathrm{BYTE}}=\mathrm{V}_{\mathrm{L}}\right)$. The address range is $\mathrm{A}_{17}: \mathrm{A}_{0}$ if in word mode $\left(\overline{\mathrm{BYTE}}=\mathrm{V}_{\mathrm{H}}\right)$.

## MBM29DL400TC-55/-70/-90/-12/MBM29DL400BC-55/-70/-90/-12

Table 7 Sector Address Tables (MBM29DL400BC)

| Bank | Sector | Sector Address |  |  |  |  |  | Sector Size (Kbytes/ Kwords) | $\stackrel{(\times 8)}{ } \text { Address Range }$ | $(\times 16)$ <br> Address Range |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | BankAddress |  | A15 | $\mathrm{A}_{14}$ | $\mathrm{A}_{13}$ | $\mathrm{A}_{12}$ |  |  |  |
|  |  | A17 | $\mathrm{A}_{16}$ |  |  |  |  |  |  |  |
| Bank 2 | SA13 | 1 | 1 | 1 | X | X | X | 64/32 | 70000 H to 7FFFFH | 38000 H to 3FFFFH |
|  | SA12 | 1 | 1 | 0 | X | X | X | 64/32 | 60000 H to 6FFFFH | 30000 H to 37FFFH |
|  | SA11 | 1 | 0 | 1 | X | X | X | 64/32 | 50000 H to 5FFFFH | 28000 H to 2FFFFH |
|  | SA10 | 1 | 0 | 0 | X | X | X | 64/32 | 40000 H to 4FFFFF | 20000 H to 27FFFH |
|  | SA9 | 0 | 1 | 1 | X | X | X | 64/32 | 30000 H to 3FFFFFH | 18000 H to 1FFFFH |
|  | SA8 | 0 | 1 | 0 | X | X | X | 64/32 | 20000 H to 2FFFFH | 10000 H to 17FFFH |
| Bank 1 | SA7 | 0 | 0 | 1 | 1 | 1 | X | 16/8 | 1 COOOH to 1FFFFH | OEOOOH to OFFFFH |
|  | SA6 | 0 | 0 | 1 | 1 | 0 | X X | 32/16 | 14000 H to 17 FFFF , 18000 H to 1 BFFFH | OAOOOH to OBFFFH, 0 COOOH to ODFFFH |
|  | SA5 | 0 | 0 | 1 | 0 | 0 | 1 | 8/4 | 12000 H to 13FFFH | 09000 H to 09FFFH |
|  | SA4 | 0 | 0 | 1 | 0 | 0 | 0 | 8/4 | 10000 H to 11FFFH | 08000 H to 08FFFH |
|  | SA3 | 0 | 0 | 0 | 1 | 1 | 1 | 8/4 | OE000H to OFFFFH | 07000H to 07FFFH |
|  | SA2 | 0 | 0 | 0 | 1 | 1 | 0 | 8/4 | OCOOOH to ODFFFH | 06000H to 06FFFH |
|  | SA1 | 0 | 0 | 0 | 1 0 | 0 1 | X | 32/16 | 08000 H to $0 B F F F H$, 04000 H to 07 FFFH | 04000 H to 05 FFFH , 02000H to 03FFFH |
|  | SAO | 0 | 0 | 0 | 0 | 0 | X | 16/8 | 00000H to 03FFFH | 00000H to 01FFFH |

Note: The address range is $A_{17}: A_{-1}$ if in byte mode $\left(\overline{\mathrm{BYTE}}=\mathrm{V}_{\mathrm{L}}\right)$. The address range is $\mathrm{A}_{17}: \mathrm{A}_{0}$ if in word mode ( $\overline{\mathrm{BYTE}}=\mathrm{V}$ н $)$.

## MBM29DL400TC-55/-70/-90/-12/MBM29DL400BC-55/-70/-90/-12

Table 8 MBM29DL400TC/BC Command Definitions

| Command Sequence |  |  | First Bus Write Cycle |  | Second Bus Write Cycle |  | Third Bus Write Cycle |  | Fourth Bus Read/Write Cycle |  | Fifth Bus Write Cycle |  | Sixth Bus Write Cycle |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | Addr. | Data | Addr. | Data | Addr. | Data | Addr. | Data | Addr. | Data | Addr. | Data |
| Read/Reset | Word |  | 1 | XXXH | F0H | - | - | - | - | - | - | - | - | - | - |
| Read/Reset | $\begin{array}{\|c\|} \hline \text { Word } \\ \hline \text { Byte } \\ \hline \end{array}$ | 3 | $555 \mathrm{H}$ <br> AAAH | AAH | $\begin{aligned} & 2 \mathrm{AAH} \\ & \hline 555 \mathrm{H} \end{aligned}$ | 55H | $\begin{gathered} \hline 555 \mathrm{H} \\ \hline \text { AAAH } \end{gathered}$ | FOH | RA | RD | - | - | - | - |
| Autoselect | Word | 3 | 555H | AAH | 2AAH | 55H | $\begin{gathered} \text { (BA) } \\ 555 \mathrm{H} \\ \hline \text { (BA) } \\ \text { AAAH } \end{gathered}$ | 90H | - | - | - | - | - | - |
| Program | $\begin{array}{\|l\|} \hline \text { Word } \\ \hline \text { Byte } \\ \hline \end{array}$ | 4 | $555 \mathrm{H}$ <br> AAAH | AAH | $\begin{aligned} & \hline 2 \mathrm{AAH} \\ & \hline 555 \mathrm{H} \end{aligned}$ | 55H | $\begin{aligned} & 555 \mathrm{H} \\ & \hline \text { AAAH } \end{aligned}$ | AOH | PA | PD | - | - | - | - |
| Chip Erase | $\begin{array}{\|l\|} \hline \text { Word } \\ \hline \text { Byte } \\ \hline \end{array}$ | 6 | $555 \mathrm{H}$ <br> AAAH | AAH | $\begin{aligned} & 2 \mathrm{AAH} \\ & \hline 555 \mathrm{H} \end{aligned}$ | 55H | $\begin{aligned} & 555 \mathrm{H} \\ & \hline \text { AAAH } \end{aligned}$ | 80H | $555 \mathrm{H}$ <br> AAAH | AAH | $\frac{2 \mathrm{AAH}}{555 \mathrm{H}}$ | 55H | $\begin{array}{\|c\|} \hline 555 \mathrm{H} \\ \hline \text { AAAH } \\ \hline \end{array}$ | 10H |
| Sector Erase | $\begin{array}{\|l\|} \hline \text { Word } \\ \hline \text { Byte } \\ \hline \end{array}$ | 6 | 555H <br> AAAH | AAH | $\begin{aligned} & \hline 2 \mathrm{AAH} \\ & \hline 555 \mathrm{H} \end{aligned}$ | 55H | $\frac{555 \mathrm{H}}{\mathrm{AAAH}}$ | 80H | $555 \mathrm{H}$ AAAH | AAH | $\frac{2 \mathrm{AAH}}{555 \mathrm{H}}$ | 55H | SA | 30 H |
| Erase Susp | nd | 1 | BA | B0H | - | - | - | - | - | - | - | - | - | - |
| Erase Resum | me | 1 | BA | 30H | - | - | - | - | - | - | - | - | - | - |
| Set to Fast Mode | $\begin{array}{\|l\|} \hline \text { Word } \\ \hline \text { Byte } \\ \hline \end{array}$ | 3 | 555H <br> AAAH | AAH | $\begin{aligned} & 2 \mathrm{AAH} \\ & \hline 555 \mathrm{H} \end{aligned}$ | 55H | $\frac{555 \mathrm{H}}{\text { AAAH }}$ | 20 H | - | - | - | - | - | - |
| Fast Program * | $\begin{array}{\|l\|} \hline \text { Word } \\ \hline \text { Byte } \\ \hline \end{array}$ | 2 | XXXH | AOH | PA | PD | - | - | - | - | - | - | - | - |
| Reset from Fast Mode * | $\begin{array}{\|l\|} \hline \text { Word } \\ \hline \text { Byte } \\ \hline \end{array}$ | 2 | $\begin{aligned} & \mathrm{BA} \\ & \hline \mathrm{BA} \end{aligned}$ | 90H | $\begin{aligned} & \mathrm{XXXH} \\ & \hline \mathrm{XXXH} \end{aligned}$ | FOH | - | - | - | - | - | - | - | - |
| Extended Sector Protect | $\begin{array}{\|l\|} \hline \text { Word } \\ \hline \text { Byte } \\ \hline \end{array}$ | 4 | XXXH | 60H | SPA | 60H | SPA | 40H | SPA | SD | - | - | - | - |

Notes: 1. Address bits $\mathrm{A}_{11}$ to $\mathrm{A}_{17}=\mathrm{X}=$ " H " or " L " for all address commands except or Program Address (PA), Sector Address (SA), and Bank Address (BA).
2. Bus operations are defined in Tables 2 and 3.
3. RA = Address of the memory location to be read

PA = Address of the memory location to be programmed Addresses are latched on the falling edge of the write pulse.
$S A=$ Address of the sector to be erased. The combination of $A_{17}, A_{16}, A_{15}, A_{14}, A_{13}$, and $A_{12}$ will uniquely select any sector.
BA = Bank Address ( $\mathrm{A}_{16}$ to $\mathrm{A}_{17}$ )
4. $\mathrm{RD}=$ Data read from location RA during read operation.

PD = Data to be programmed at location PA. Data is latched on the falling edge of write pulse.
5. SPA $=$ Sector address to be protected. Set sector address $(S A)$ and $\left(A_{6}, A_{1}, A_{0}\right)=(0,1,0)$.

SD $=$ Sector protection verify data. Output 01 H at protected sector addresses and output 00 H at unprotected sector addresses.
*: This command is valid while Fast Mode.
6. The system should generate the following address patterns:

Word Mode: 555 H or 2AAH to addresses $\mathrm{A}_{0}$ to $\mathrm{A}_{10}$
Byte Mode: AAAH or 555H to addresses $\mathrm{A}_{-1}$ and $\mathrm{A}_{0}$ to $\mathrm{A}_{10}$
7. Both Read/Reset commands are functionally equivalent, resetting the device to the read mode.

## MBM29DL400TC-55/-70-90/-12/MBM29DL400BC-55/-70/-90-12

## Command Definitions

Device operations are selected by writing specific address and data sequences into the command register. Writing incorrect address and data values or writing them in the improper sequence will reset the devices to the read mode. Some commands are required Bank Address (BA) input. When command sequences are inputed to bank being read, the commands have priority than reading. Table 8 defines the valid register command sequences. Note that the Erase Suspend $(\mathrm{BOH})$ and Erase Resume $(30 \mathrm{H})$ commands are valid only while the Sector Erase operation is in progress. Moreover both Read/Reset commands are functionally equivalent, resetting the device to the read mode. Please note that commands are always written at $\mathrm{DQ}_{0}$ to $\mathrm{DQ}_{7}$ and $\mathrm{DQ}_{8}$ to DQ15 bits are ignored.

## Read/Reset Command

In order to return from Autoselect mode or Exceeded Timing Limits ( $\mathrm{DQ}_{5}=1$ ) to Read/Reset mode, the Read/ Reset operation is initiated by writing the Read/Reset command sequence into the command register. Microprocessor read cycles retrieve array data from the memory. The devices remain enabled for reads until the command register contents are altered.

The devices will automatically power-up in the Read/Reset state. In this case, a command sequence is not required to read data. Standard microprocessor read cycles will retrieve array data. This default value ensures that no spurious alteration of the memory content occurs during the power transition. Refer to the AC Read Characteristics and Waveforms for the specific timing parameters.

## Autoselect Command

Flash memories are intended for use in applications where the local CPU alters memory contents. As such, manufacture and device codes must be accessible while the devices reside in the target system. PROM programmers typically access the signature codes by raising $\mathrm{A}_{9}$ to a high voltage. However, multiplexing high voltage onto the address lines is not generally desired system design practice.

The device contains an Autoselect command operation to supplement traditional PROM programming methodology. The operation is initiated by writing the Autoselect command sequence into the command register.

The Autoselect command sequence is initiated by first writing two unlock cycles. This is followed by a third write cycle that contains the bank address (BA) and the Autoselect command. Then the manufacture and device codes can be read from the bank, and an actual data of memory cell can be read from the another bank.

Following the command write, a read cycle from address (BA)00H retrieves the manufacture code of $04 \mathrm{H} . \mathrm{A}$ read cycle from address (BA)01H for $\times 16((\mathrm{BA}) 02 \mathrm{H}$ for $\times 8$ ) returns the device code (MBM29DL400TC $=0 \mathrm{CH}$ and MBM29DL400BC $=0$ FH for $\times 8$ mode; MBM29DL400TC $=220 \mathrm{CH}$ and MBM29DL400BC $=220 \mathrm{FH}$ for $\times 16$ mode). (See Tables 5.1 and 5.2.)

All manufacturer and device codes will exhibit odd parity with $\mathrm{DQ}_{7}$ defined as the parity bit. Sector state (protection or unprotection) will be informed by address (BA)02H for $\times 16$ ((BA) 04 H for $\times 8$ ). Scanning the sector addresses ( $A_{17}, A_{16}, A_{15}, A_{14}, A_{13}$, and $A_{12}$ ) while ( $\left.A_{6}, A_{1}, A_{0}\right)=(0,1,0)$ will produce a logical " 1 " at device output $D Q_{0}$ for a protected sector. The programming verification should be performed by verify sector protection on the protected sector. (See Tables 2 and 3.)

The manufacture and device codes can be allowed reading from selected bank. To read the manufacture and device codes and sector protection status from non-selected bank, it is necessary to write Read/Reset command sequence into the register and then Autoselect command should be written into the bank to be read.

If the software (program code) for Autoselect command is stored into the Frash memory, the device and manufacture codes should be read from the other bank where is not contain the software.

## MBM29DL400TC-55/-70/-90/-12/MBM29DL400BC-55/-70/-90/-12

To terminate the operation, it is necessary to write the Read/Reset command sequence into the register, and also to write the Autoselect command during the operation, execute it after writing Read/Reset command sequence.

## Byte/Word Programming

The devices are programmed on a byte-by-byte (or word-by-word) basis. Programming is a four bus cycle operation. There are two "unlock" write cycles. These are followed by the program set-up command and data write cycles. Addresses are latched on the falling edge of $\overline{C E}$ or $\overline{W E}$, whichever happens later and the data is latched on the rising edge of $\overline{\mathrm{CE}}$ or $\overline{\mathrm{WE}}$, whichever happens first. The rising edge of $\overline{\mathrm{CE}}$ or $\overline{\mathrm{WE}}$ (whichever happens first) begins programming. Upon executing the Embedded Program Algorithm command sequence, the system is not required to provide further controls or timings. The device will automatically provide adequate internally generated program pulses and verify the programmed cell margin.

The system can determine the status of the program operation by using DQ ( $\overline{\text { Data }}$ Polling), DQ ${ }_{6}$ (Toggle Bit), or RY/BY. The $\overline{\text { Data }}$ Polling and Toggle Bit must be performed at the memory location which is being programmed.

The automatic programming operation is completed when the data on DQ7 is equivalent to data written to this bit at which time the devices return to the read mode and addresses are no longer latched. (See Table 9, Hardware Sequence Flags.) Therefore, the devices require that a valid address to the devices be supplied by the system at this particular instance of time. Hence, $\overline{\text { Data }}$ Polling must be performed at the memory location which is being programmed.
Any commands written to the chip during this period will be ignored. If hardware reset occurs during the programming operation, it is impossible to guarantee the data are being written.

Programming is allowed in any sequence and across sector boundaries. Beware that a data "0" cannot be programmed back to a "1". Attempting to do so may either hang up the device or result in an apparent success according to the data polling algorithm but a read from Read/Reset mode will show that the data is still "0". Only erase operations can convert " 0 "s to " 1 "s.

Figure 21 illustrates the Embedded Program ${ }^{\text {TM }}$ Algorithm using typical command strings and bus operations.

## Chip Erase

Chip erase is a six bus cycle operation. There are two "unlock" write cycles. These are followed by writing the "set-up" command. Two more "unlock" write cycles are then followed by the chip erase command.

Chip erase does not require the user to program the device prior to erase. Upon executing the Embedded Erase Algorithm command sequence the devices will automatically program and verify the entire memory for an all zero data pattern prior to electrical erase (Preprogram function). The system is not required to provide any controls or timings during these operations.

The system can determine the status of the erase operation by using DQ7 ( $\overline{\text { Data }}$ Polling), DQ (Toggle Bit), or $\mathrm{RY} / \overline{\mathrm{BY}}$. The chip erase begins on the rising edge of the last $\overline{\mathrm{CE}}$ or $\overline{\mathrm{WE}}$, whichever happens first in the command sequence and terminates when the data on $\mathrm{DQ}_{7}$ is " 1 " (See Write Operation Status section.) at which time the device returns to read the mode.

Chip Erase Time; Sector Erase Time $\times$ All sectors + Chip Program Time (Preprogramming)
Figure 22 illustrates the Embedded Erase ${ }^{\mathrm{TM}}$ Algorithm using typical command strings and bus operations.

## MBM29DL400TC-55/-70/-90/-12/MBM29DL400BC-55/-70/-90/-12

## Sector Erase

Sector erase is a six bus cycle operation. There are two "unlock" write cycles. These are followed by writing the "set-up" command. Two more "unlock" write cycles are then followed by the Sector Erase command. The sector address (any address location within the desired sector) is latched on the falling edge of $\overline{\mathrm{CE}}$ or $\overline{\mathrm{WE}}$ whichever happens later, while the command ( $\mathrm{Data}=30 \mathrm{H}$ ) is latched on the rising edge of $\overline{\mathrm{CE}}$ or $\overline{\mathrm{WE}}$ which happens first. After time-out of $50 \mu \mathrm{~s}$ from the rising edge of the last sector erase command, the sector erase operation will begin.

Multiple sectors may be erased concurrently by writing the six bus cycle operations on Table 8. This sequence is followed with writes of the Sector Erase command to addresses in other sectors desired to be concurrently erased. The time between writes must be less than $50 \mu \mathrm{~s}$ otherwise that command will not be accepted and erasure will start. It is recommended that processor interrupts be disabled during this time to guarantee this condition. The interrupts can be re-enabled after the last Sector Erase command is written. A time-out of $50 \mu \mathrm{~s}$ from the rising edge of last CE or WE whichever happens first will initiate the execution of the Sector Erase command(s). If another falling edge of $\overline{\mathrm{CE}}$ or $\overline{\mathrm{WE}}$, whichever happens first occurs within the $50 \mu \mathrm{~s}$ time-out window the timer is reset. (Monitor $\mathrm{DQ}_{3}$ to determine if the sector erase timer window is still open, see section $\mathrm{DQ}_{3}$, Sector Erase Timer.) Any command other than Sector Erase or Erase Suspend during this time-out period will reset the devices to the read mode, ignoring the previous command string. Resetting the devices once execution has begun will corrupt the data in the sector. In that case, restart the erase on those sectors and allow them to complete. (Refer to the Write Operation Status section for Sector Erase Timer operation.) Loading the sector erase buffer may be done in any sequence and with any number of sectors ( 0 to 13).

Sector erase does not require the user to program the devices prior to erase. The devices automatically program all memory locations in the sector(s) to be erased prior to electrical erase (Preprogram function). When erasing a sector or sectors the remaining unselected sectors are not affected. The system is not required to provide any controls or timings during these operations.

The system can determine the status of the erase operation by using DQ ( $\overline{\text { Data }}$ Polling), DQ6 (Toggle Bit), or $\mathrm{RY} / \overline{\mathrm{BY}}$.

The sector erase begins after the $50 \mu \mathrm{~s}$ time out from the rising edge of $\overline{\mathrm{CE}}$ or $\overline{\mathrm{WE}}$ whichever happens first for the last sector erase command pulse and terminates when the data on DQ ${ }_{7}$ is " 1 " (See Write Operation Status section.) at which time the devices return to the read mode. Data polling and Toggle Bit must be performed at an address within any of the sectors being erased.

## Multiple Sector Erase Time; [Sector Erase Time + Sector Program Time (Preprogramming)] $\times$ Number of Sector Erase

In case of multiple sector erase across bank boundaries, a read from bank (read-while-erase) can not performe.
Figure 22 illustrates the Embedded Erase ${ }^{\top \mathrm{M}}$ Algorithm using typical command strings and bus operations.

## Erase Suspend/Resume

The Erase Suspend command allows the user to interrupt a Sector Erase operation and then perform data reads from or programs to a sector not being erased. This command is applicable ONLY during the Sector Erase operation which includes the time-out period for sector erase. The Erase Suspend command will be ignored if written during the Chip Erase operation or Embedded Program Algorithm. Writting the Erase Suspend command $(\mathrm{BOH})$ during the Sector Erase time-out results in immediate termination of the time-out period and suspension of the erase operation.

Writing the Erase Resume command (30H) resumes the erase operation. The bank addresses of sector being erasing or suspending should be set when writting the Erase Suspend or Erase Resume command.

## MBM29DL400TC-55/-70/-90/-12/MBM29DL400BC-55/-70/-90/-12


#### Abstract

When the Erase Suspend command is written during the Sector Erase operation, the device will take a maximum of $20 \mu \mathrm{~s}$ to suspend the erase operation. When the devices have entered the erase-suspended mode, the RY/ $\overline{\mathrm{BY}}$ output pin will be at $\mathrm{Hi}-\mathrm{Z}$ and the $\mathrm{DQ}_{7}$ bit will be at logic " 1 ", and $\mathrm{DQ}_{6}$ will stop toggling. The user must use the address of the erasing sector for reading $\mathrm{DQ}_{6}$ and $\mathrm{DQ}_{7}$ to determine if the erase operation has been suspended. Further writes of the Erase Suspend command are ignored.

When the erase operation has been suspended, the devices default to the erase-suspend-read mode. Reading data in this mode is the same as reading from the standard read mode except that the data must be read from sectors that have not been erase-suspended. Successively reading from the erase-suspended sector while the device is in the erase-suspend-read mode will cause $\mathrm{DQ}_{2}$ to toggle. (See the section on DQ2.) After entering the erase-suspend-read mode, the user can program the device by writing the appropriate command sequence for Program. This program mode is known as the erase-suspend-program mode. Again, programming in this mode is the same as programming in the regular Program mode except that the data must be programmed to sectors that are not erase-suspended. Successively reading from the erase-suspended sector while the devices are in the erase-suspend-program mode will cause DQ2 to toggle. The end of the erasesuspended Program operation is detected by the RY/BY output pin, Data polling of DQ7 or by the Toggle Bit I (DQ6) which is the same as the regular Program operation. Note that DQ7 must be read from the Program address while $\mathrm{DQ}_{6}$ can be read from any address within bank being erase-suspended. To resume the operation of Sector Erase, the Resume command $(30 \mathrm{H})$ should be written to the bank being erase suspended. Any further writes of the Resume command at this point will be ignored. Another Erase Suspend command can be written after the chip has resumed erasing.


## Extended Command

(1) Fast Mode

MBM29DL400TC/BC has Fast Mode function. This mode dispenses with the initial two unclock cycles required in the standard program command sequence by writing Fast Mode command into the command register. In this mode, the required bus cycle for programming is two cycles instead of four bus cycles in standard program command. (Do not write erase command in this mode.) The read operation is also executed after exiting this mode. To exit this mode, it is necessary to write Fast Mode Reset command into the command register. The first cycle must contain the bank address. (Refer to the Figure 28 Extended algorithm.) The Vcc active current is required even $\overline{\mathrm{CE}}=\mathrm{V}_{\boldsymbol{\mathrm { H }}}$ during Fast Mode.
(2) Fast Programming

During Fast Mode, the programming can be executed with two bus cycles operation. The Embedded Program Algorithm is executed by writing program set-up command (AOH) and data write cycles (PA/PD). (Refer to the Figure 28 Extended algorithm.)
(3) Extended Sector Protection

In addition to normal sector protection, the MBM29DL400TC/BC has Extended Sector Protection as extended function. This function enable to protect sector by forcing Vio on RESET pin and write a commnad sequence. Unlike conventional procedure, it is not necessary to force $\mathrm{V}_{10}$ and control timing for control pins. The only RESET pin requires Vio for sector protection in this mode. The extended sector protect requires $V_{I D}$ on RESET pin. With this condition, the operation is initiated by writing the set-up command ( 60 H ) into the command register. Then, the sector addresses pins ( $A_{17}, A_{16}, A_{15}, A_{14}, A_{13}$ and $A_{12}$ ) and ( $A_{6}, A_{1}, A_{0}$ ) $=(0$, 1,0 ) should be set to the sector to be protected (recommend to set $\mathrm{V}_{\mathrm{IL}}$ for the other addresses pins), and write extended sector protect command ( 60 H ). A sector is typically protected in $150 \mu \mathrm{~s}$. To verify programming of the protection circuitry, the sector addresses pins ( $\mathrm{A}_{17}, \mathrm{~A}_{16}, \mathrm{~A}_{15}, \mathrm{~A}_{14}, \mathrm{~A}_{13}$ and $\mathrm{A}_{12}$ ) and ( $\left.\mathrm{A}_{6}, \mathrm{~A}_{1}, \mathrm{~A}_{0}\right)=(0,1$, 0 ) should be set and write a command ( 40 H ). Following the command write, a logical "1" at device output $\mathrm{DQ}_{0}$ will produce for protected sector in the read operation. If the output data is logical " 0 ", please repeat to write extended sector protect command ( 60 H ) again. To terminate the operation, it is necessary to set RESET pin to $\mathrm{V}_{\mathrm{I}}$.

## MBM29DL400TC-55/-70/-90/-12/MBM29DL400BC-55/-70/-90/-12

## Write Operation Status

Detailed in Table 9 are all the status flags that can determine the status of the bank for the current mode operation. The read operation from the bank where is not operate Embedded Algorithm returns a data of memory cell. These bits offer a method for determining whether a Embedded Algorithm is completed properly. The information on $\mathrm{DQ}_{2}$ is address sensitive. This means that if an address from an erasing sector is consectively read, then the $\mathrm{DQ}_{2}$ bit will toggle. However, $\mathrm{DQ}_{2}$ will not toggle if an address from a non-erasing sector is consectively read. This allows the user to determine which sectors are erasing and which are not.

The status flag is not output from bank (non-busy bank) not executing Embedded Algorithm. For example, there is bank (busy bank) which is now executing Embedded Algorithm. When the read sequence is [1] <busy bank>, [2] <non-busy bank>, [3] <busy bank>, the DQ6 is toggling in the case of [1] and [3]. In case of [2], the data of memory cell is outputted. In the erase-suspend read mode with the same read sequence, $\mathrm{DQ}_{6}$ will not be toggled in the [1] and [3].
In the erase suspend read mode, $\mathrm{DQ}_{2}$ is toggled in the [1] and [3]. In case of [2], the data of memory cell is outputted.

Table 9 Hardware Sequence Flags

| Status |  |  | DQ7 | DQ6 | DQ5 | DQ3 | DQ ${ }_{2}$ |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| In Progress | Embedded Program Algorithm |  | $\overline{\overline{D Q}_{7}}$ | Toggle | 0 | 0 | 1 |
|  | Embedded Erase Algorithm |  | 0 | Toggle | 0 | 1 | Toggle (Note 1) |
|  | Erase <br> Suspended <br> Mode | Erase Suspend Read (Erase Suspended Sector) | 1 | 1 | 0 | 0 | Toggle |
|  |  | Erase Suspend Read (Non-Erase Suspended Sector) | Data | Data | Data | Data | Data |
|  |  | Erase Suspend Program (Non-Erase Suspended Sector) | $\overline{\mathrm{DQ}} 7$ | Toggle | 0 | 0 | $\begin{gathered} 1 \\ \text { (Note 1) } \end{gathered}$ |
| Exceeded Time Limits | Embedded Program Algorithm |  | $\overline{\mathrm{DQ}}_{7}$ | Toggle | 1 | 0 | 1 |
|  | Embedded Erase Algorithm |  | 0 | Toggle | 1 | 1 | N/A |
|  | Erase <br> Suspended <br> Mode | Erase Suspend Program <br> (Non-Erase Suspended Sector) | $\overline{\mathrm{DQ}}{ }_{7}$ | Toggle | 1 | 0 | N/A |

Notes: 1. Successive reads from the erasing or erase-suspend sector will cause $\mathrm{DQ}_{2}$ to toggle. Reading from non-erase suspend sector address will indicate logic "1" at the DQ2 bit.
2. $D Q_{0}$ and $\mathrm{DQ}_{1}$ are reserve pins for future use.
3. $\mathrm{DQ}_{4}$ is Fujitsu internal use only.

## MBM29DL400TC-55/-70/-90/-12/MBM29DL400BC-55/-70/-90/-12

## DQ7

Data Polling
The MBM29DL400TC/BC devices feature $\overline{\text { Data }}$ Polling as a method to indicate to the host that the Embedded Algorithms are in progress or completed. During the Embedded Program Algorithm an attempt to read the devices will produce the complement of the data last written to DQ7. Upon completion of the Embedded Program Algorithm, an attempt to read the device will produce the true data last written to DQ7. During the Embedded Erase Algorithm, an attempt to read the device will produce a " 0 " at the DQ7 output. Upon completion of the Embedded Erase Algorithm an attempt to read the device will produce a "1" at the DQ7 output. The flowchart for Data Polling ( $\mathrm{DQ}_{7}$ ) is shown in Figure 23.

For programming, the Data Polling is valid after the rising edge of fourth write pulse in the four write pulse sequence.

For chip erase and sector erase, the $\overline{\text { Data }}$ Polling is valid after the rising edge of the sixth write pulse in the six write pulse sequence. Data Polling must be performed at sector address within any of the sectors being erased and not a protected sector. Otherwise, the status may not be valid.
If a program address falls within a protected sector, $\overline{\text { Data }}$ Polling on $\mathrm{DQ}_{7}$ is active for approximately $1 \mu \mathrm{~s}$, then that bank returns to the read mode. After an erase command sequence is written, if all sectors selected for erasing are protected, Data Polling on DQ7 is active for approximately $100 \mu \mathrm{~s}$, then the bank returns to read mode.

Once the Embedded Algorithm operation is close to being completed, the MBM29DL400TC/BC data pins (DQ7) may change asynchronously while the output enable ( $\overline{\mathrm{OE}}$ ) is asserted low. This means that the devices are driving status information on DQ7 at one instant of time and then that byte's valid data at the next instant of time. Depending on when the system samples the $\mathrm{DQ}_{7}$ output, it may read the status or valid data. Even if the device has completed the Embedded Algorithm operation and $\mathrm{DQ}_{7}$ has a valid data, the data outputs on $\mathrm{DQ}_{0}$ to $\mathrm{DQ}_{6}$ may be still invalid. The valid data on $\mathrm{DQ}_{0}$ to $\mathrm{DQ}_{7}$ will be read on the successive read attempts.
The $\overline{\text { Data }}$ Polling feature is only active during the Embedded Programming Algorithm, Embedded Erase Algorithm or sector erase time-out. (See Table 9.)

See Figure 9 for the $\overline{\text { Data }}$ Polling timing specifications and diagrams.

## DQ6

## Toggle Bit I

The MBM29DL400TC/BC also feature the "Toggle Bit l" as a method to indicate to the host system that the Embedded Algorithms are in progress or completed.
During an Embedded Program or Erase Algorithm cycle, successive attempts to read ( $\overline{\mathrm{OE}}$ toggling) data from the devices will result in DQ6 toggling between one and zero. Once the Embedded Program or Erase Algorithm cycle is completed, DQ6 will stop toggling and valid data will be read on the next successive attempts. During programming, the Toggle Bit I is valid after the rising edge of the fourth write pulse in the four write pulse sequence. For chip erase and sector erase, the Toggle Bit I is valid after the rising edge of the sixth write pulse in the six write pulse sequence. The Toggle Bit I is active during the sector time out.

In programming, if the sector being written to is protected, the toggle bit will toggle for about $2 \mu$ s and then stop toggling without the data having changed. In erase, the devices will erase all the selected sectors except for the ones that are protected. If all selected sectors are protected, the chip will toggle the toggle bit for about $100 \mu \mathrm{~s}$ and then drop back into read mode, having changed none of the data.
Either $\overline{\mathrm{CE}}$ or $\overline{\mathrm{OE}}$ toggling will cause the $\mathrm{DQ}_{6}$ to toggle. In addition, an Erase Suspend/Resume command will cause the $\mathrm{DQ}_{6}$ to toggle.

## MBM29DL400TC.-55/-70-90-12/MBM29DL400BC. $55-70 \cdot-90-12$

The system can use $\mathrm{DQ}_{6}$ to determine whether a sector is actively erasing or is erase-suspended. When a bank is actively erasing (that is, the Embedded Erase Algorithm is in progress), $\mathrm{DQ}_{6}$ toggles. When a bank enters the Erase Suspend mode, $\mathrm{DQ}_{6}$ stops toggling. Successive read cycles during the erase-suspend-program cause $D Q_{6}$ to toggle.

To operate toggle bit function properly, $\overline{\mathrm{CE}}$ or $\overline{\mathrm{OE}}$ must be high when bank address is changed.
See Figure 10 for the Toggle Bit I timing specifications and diagrams.

## DQ5

Exceeded Timing Limits
DQ5 will indicate if the program or erase time has exceeded the specified limits (internal pulse count). Under these conditions DQ5 will produce a " 1 ". This is a failure condition which indicates that the program or erase cycle was not successfully completed. Data Polling is the only operating function of the devices under this condition. The $\overline{\mathrm{CE}}$ circuit will partially power down the device under these conditions (to approximately 2 mA ). The $\overline{\mathrm{OE}}$ and $\overline{\mathrm{WE}}$ pins will control the output disable functions as described in Tables 2 and 3.

The DQs failure condition may also appear if a user tries to program a non blank location without erasing. In this case the devices lock out and never complete the Embedded Algorithm operation. Hence, the system never reads a valid data on DQ7 bit and $\mathrm{DQ}_{6}$ never stops toggling. Once the devices have exceeded timing limits, the DQ5 bit will indicate a "1." Please note that this is not a device failure condition since the devices were incorrectly used. If this occurs, reset the device with command sequence.
$D_{3}$
Sector Erase Timer
After the completion of the initial sector erase command sequence the sector erase time-out will begin. DQ will remain low until the time-out is complete. Data Polling and Toggle Bit are valid after the initial sector erase command sequence.

If $\overline{\text { Data }}$ Polling or the Toggle Bit I indicates the device has been written with a valid erase command, $\mathrm{DQ}_{3}$ may be used to determine if the sector erase timer window is still open. If $\mathrm{DQ}_{3}$ is high ("1") the internally controlled erase cycle has begun; attempts to write subsequent commands to the device will be ignored until the erase operation is completed as indicated by Data Polling or Toggle Bit I. If $\mathrm{DQ}_{3}$ is low ("0"), the device will accept additional sector erase commands. To insure the command has been accepted, the system software should check the status of DQ 3 prior to and following each subsequent Sector Erase command. If $\mathrm{DQ}_{3}$ were high on the second status check, the command may not have been accepted.

See Table 9: Hardware Sequence Flags.
$D_{2}$
Toggle Bit II
This toggle bit II, along with DQ6, can be used to determine whether the devices are in the Embedded Erase Algorithm or in Erase Suspend.

Successive reads from the erasing sector will cause $\mathrm{DQ}_{2}$ to toggle during the Embedded Erase Algorithm. If the devices are in the erase-suspended-read mode, successive reads from the erase-suspended sector will cause DQ to toggle. When the devices are in the erase-suspended-program mode, successive reads from the byte address of the non-erase suspended sector will indicate a logic " 1 " at the $\mathrm{DQ}_{2}$ bit.
$\mathrm{DQ}_{6}$ is different from $\mathrm{DQ}_{2}$ in that $\mathrm{DQ}_{6}$ toggles only when the standard program or Erase, or Erase Suspend Program operation is in progress. The behavior of these two status bits, along with that of $\mathrm{DQ}_{7}$, is summarized as follows:

## MBM29DL400TC-55/-70/-90/-12/MBM29DL400BC-55/-70/-90/-12

For example, $\mathrm{DQ}_{2}$ and $\mathrm{DQ}_{6}$ can be used together to determine if the erase-suspend-read mode is in progress. (DQ2 toggles while DQ6 does not.) See also Table 9 and Figure 19.
Furthermore, $\mathrm{DQ}_{2}$ can also be used to determine which sector is being erased. When the device is in the erase mode, $\mathrm{DQ}_{2}$ toggles if this bit is read from an erasing sector.
To operate toggle bit function properly, $\overline{\mathrm{CE}}$ or $\overline{\mathrm{OE}}$ must be high when bank address is changed.

| Mode | $\mathbf{D Q}_{7}$ | $\mathbf{D Q}_{6}$ | $\mathbf{D Q}_{\mathbf{2}}$ |
| :--- | :---: | :---: | :---: |
| Program | $\overline{\mathrm{DQ}}_{7}$ | Toggle | 1 |
| Erase | 0 | Toggle | Toggle (Note) |
| Erase-Suspend Read <br> (Erase-Suspended Sector) <br> (Note 1) | 1 | 1 | Toggle |
| Erase-Suspend Program | $\overline{\mathrm{DQ}}_{7}$ | Toggle | 1 (Note) |

Note: Successive reads from the erasing or erase-suspend sector will cause $\mathrm{DQ}_{2}$ to toggle. Reading from nonerase suspend sector address will indicate logic "1" at the DQ2 bit.

## RY/ $\overline{\mathbf{B Y}}$

## Ready/Busy

The MBM29DL400TC/BC provide a RY/ $\overline{B Y}$ open-drain output pin as a way to indicate to the host system that the Embedded Algorithms are either in progress or has been completed. If the output is low, the devices are busy with either a program or erase operation. If the output is high, the devices are ready to accept any read/ write or erase operation. When the $\mathrm{RY} / \overline{\mathrm{BY}}$ pin is low, the devices will not accept any additional program or erase commands. If the MBM29DL400TC/BC are placed in an Erase Suspend mode, the RY/BY output will be high.

During programming, the RY/BY pin is driven low after the rising edge of the fourth write pulse. During an erase operation, the $\mathrm{RY} / \overline{\mathrm{BY}}$ pin is driven low after the rising edge of the sixth write pulse. The RY/ $\overline{\mathrm{BY}}$ pin will indicate a busy condition during the $\overline{\text { RESET }}$ pulse. Refer to Figure 11 and 12 for a detailed timing diagram. The RY/ $\overline{\mathrm{BY}}$ pin is pulled high in standby mode.
Since this is an open-drain output, $\mathrm{RY} / \overline{\mathrm{BY}}$ pins can be tied together in parallel with a pull-up resistor to $\mathrm{V} c \mathrm{c}$.

## Byte/Word Configuration

The BYTE pin selects the byte (8-bit) mode or word (16-bit) mode for the MBM29DL400TC/BC devices. When this pin is driven high, the devices operate in the word (16-bit) mode. The data is read and programmed at DQ0 to DQ15. When this pin is driven low, the devices operate in byte (8-bit) mode. Under this mode, the DQ $15 / \mathrm{A}_{-1}$ pin becomes the lowest address bit and DQ8 to DQ14 bits are tri-stated. However, the command bus cycle is always an 8-bit operation and hence commands are written at $\mathrm{DQ}_{0}$ to $\mathrm{DQ}_{7}$ and the $\mathrm{DQ}_{8}$ to $\mathrm{DQ}_{15}$ bits are ignored. Refer to Figures 13,14 and 15 for the timing diagram.

## Data Protection

The MBM29DL400TC/BC are designed to offer protection against accidental erasure or programming caused by spurious system level signals that may exist during power transitions. During power up the devices automatically reset the internal state machine in the Read mode. Also, with its control register architecture, alteration of the memory contents only occurs after successful completion of specific multi-bus cycle command sequences.

The devices also incorporate several features to prevent inadvertent write cycles resulting form Vcc power-up and power-down transitions or system noise.

## MBM29DL400TC-55/-70-90/-12/MBM29DL400BC-55/-70-90/-12

## Low Vcc Write Inhibit

To avoid initiation of a write cycle during Vcc power-up and power-down, a write cycle is locked out for Vcc less than 2.3 V (typically 2.4 V ). If Vcc < Vıко, the command register is disabled and all internal program/erase circuits are disabled. Under this condition the device will reset to the read mode. Subsequent writes will be ignored until the $\mathrm{V}_{\text {cc }}$ level is greater than $\mathrm{V}_{\text {Lko. }}$. It is the users responsibility to ensure that the control pins are logically correct to prevent unintentional writes when V cc is above 2.3 V .

If Embedded Erase Algorithm is interrupted, there is possibility that the erasing sector(s) cannot be used.

## Write Pulse "Glitch" Protection

Noise pulses of less than 5 ns (typical) on $\overline{\mathrm{OE}}, \overline{\mathrm{CE}}$, or $\overline{\mathrm{WE}}$ will not initiate a write cycle.

## Logical Inhibit

Writing is inhibited by holding any one of $\overline{\mathrm{OE}}=\mathrm{V}_{\mathrm{IL}}, \overline{\mathrm{CE}}=\mathrm{V}_{\mathrm{H}}$, or $\overline{\mathrm{WE}}=\mathrm{V}_{\mathrm{I}}$. To initiate a write cycle $\overline{\mathrm{CE}}$ and $\overline{\mathrm{WE}}$ must be a logical zero while $\overline{\mathrm{OE}}$ is a logical one.

## Power-Up Write Inhibit

Power-up of the devices with $\overline{\mathrm{WE}}=\overline{\mathrm{CE}}=\mathrm{V}_{\mathrm{IL}}$ and $\overline{\mathrm{OE}}=\mathrm{V}_{\mathrm{IH}}$ will not accept commands on the rising edge of $\overline{\mathrm{WE}}$. The internal state machine is automatically reset to the read mode on power-up.

## MBM29DL400TC-55/-70-90/-12/MBM29DL400BC-55/-70-90/-12

## ABSOLUTE MAXIMUM RATINGS

| Stor | $55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ |
| :---: | :---: |
| Ambient Temperature with Power Applied | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ |
|  | -0.5 V to V $\mathrm{cc}+0.5 \mathrm{~V}$ |
| Vcc (Note 1) | -0.5 V to +5.5 V |
| $\mathrm{A}_{9}, \overline{\mathrm{OE}}$, and $\overline{\mathrm{RESET}}$ (Note 2) | -0.5 V to +13.0 V |

Notes: 1. Minimum DC voltage on input or I/O pins are -0.5 V . During voltage transitions, inputs may negative overshoot Vss to -2.0 V for periods of up to 20 ns . Maximum DC voltage on output and I/O pins are Vcc +0.5 V . During voltage transitions, outputs may positive overshoot to $\mathrm{Vcc}+2.0 \mathrm{~V}$ for periods of up to 20 ns .
2. Minimum DC input voltage on $A 9, \overline{\mathrm{OE}}$ and $\overline{\mathrm{RESET}}$ pins are -0.5 V . During voltage transitions, $\mathrm{A} 9, \overline{\mathrm{OE}}$ and $\overline{\text { RESET }}$ pins may negative overshoot V ss to -2.0 V for periods of up to 20 ns . Maximum DC input voltage on A 9 , $\overline{\mathrm{OE}}$ and RESET pins are +13.0 V which may positive overshoot to 14.0 V for periods of up to 20 ns . when $\mathrm{V}_{\mathrm{cc}}$ is applied.
WARNING: Semiconductor devices can be permanently damaged by application of stress (voltage, current, temperature, etc.) in excess of absolute maximum ratings. Do not exceed these ratings.

## ■ RECOMMENDED OPERATING RANGES

| Ambient Temperature ( $\mathrm{T}_{\mathrm{A}}$ ) |  |
| :---: | :---: |
| MBM29DL400TC/BC-55 | $-20^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ |
| MBM29DL400TC/BC-70/-90/-12 | - $40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ |
| Vcc Supply Voltages |  |
| MBM29DL400TC/BC-55/-70 | +3.0 V to +3.6 V |
| MBM29DL400TC/BC-90/-12 | +2.7 V to +3.6 V |

Operating ranges define those limits between which the functionality of the devices are guaranteed.
WARNING: The recommended operating conditions are required in order to ensure the normal operation of the semiconductor device. All of the device's electrical characteristics are warranted when the dwvice is perated within these ranges.
Always use semiconductor devices within their recommended operating condition ranges. Operation outside these ranges may adversely affect reliability and could result in device failure.
No warranty is made with respect to uses, operating conditions, or combinations not represented on the data sheet. Users considering application outside the listed conditions are advised to contact their FUJITSU representatives beforehand.

## MBM29DL400TC.-55/-70-90-12/MBM29DL400BC-55-70-90-12

## MAXIMUM OVERSHOOT



Figure 1 Maximum Negative Overshoot Waveform


Figure 2 Maximum Positive Overshoot Waveform 1

*: This waveform is applied for $\mathrm{A} 9, \overline{\mathrm{OE}}$, and $\overline{\mathrm{RESET}}$.

Figure 3 Maximum Positive Overshoot Waveform 2

## MBM29DL400TC-55/-70/-90/-12/MBM29DL400BC-55/-70/-90/-12

## DC CHARACTERISTICS

| Parameter Symbol | Parameter Description | Test Conditions |  | Min. | Max. | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| IL | Input Leakage Current | $\mathrm{V}_{\mathrm{in}}=\mathrm{V}_{\mathrm{ss}}$ to $\mathrm{V}_{\mathrm{cc}}, \mathrm{V}_{\mathrm{cc}}=\mathrm{V}_{\mathrm{cc}}$ Max. |  | -1.0 | +1.0 | $\mu \mathrm{A}$ |
| ILo | Output Leakage Current | Vout $=$ Vss to $\mathrm{V}_{\mathrm{cc}}$, V cc $=\mathrm{V}$ cc Max. |  | -1.0 | +1.0 | $\mu \mathrm{A}$ |
| ІІт | $\mathrm{A}_{9}, \overline{\mathrm{OE}}, \overline{\mathrm{RESET}}$ Inputs Leakage Current | $V_{c c}=V_{c c}$ Max. <br> A $9, \overline{\mathrm{OE}}, \mathrm{RESET}=12.5 \mathrm{~V}$ |  | - | 35 | $\mu \mathrm{A}$ |
| Iccı | Vcc Active Current (Note 1) | $\begin{aligned} & \overline{\mathrm{CE}}=\mathrm{V}_{\mathrm{LL}}, \overline{\mathrm{OE}}=\mathrm{V}_{\mathrm{H}}, \\ & \mathrm{f}=10 \mathrm{MHz} \end{aligned}$ | Byte | - | 18 | mA |
|  |  |  | Word |  | 20 |  |
|  |  | $\begin{aligned} & \overline{C E}=V_{\mathrm{IL}}, \overline{\mathrm{OE}}=\mathrm{V}_{\mathrm{H}}, \\ & \mathrm{f}=5 \mathrm{MHz} \end{aligned}$ | Byte | - | 8 | mA |
|  |  |  | Word |  | 10 |  |
| Icc2 | Vcc Active Current (Note 2) | $\overline{\mathrm{CE}}=\mathrm{V}_{\text {IL }}, \overline{\mathrm{OE}}=\mathrm{V}_{\text {IH }}$ |  | - | 35 | mA |
| Icc3 | Vcc Current (Standby) | $\begin{aligned} & \mathrm{V}_{\mathrm{cc}}=\mathrm{V}_{\mathrm{cc}} \mathrm{Max.}, \overline{\mathrm{CE}}=\mathrm{V}_{\mathrm{cc}} \pm 0.3 \mathrm{~V}, \\ & \mathrm{RESET}=\mathrm{V}_{\mathrm{cc}} \pm 0.3 \mathrm{~V} \end{aligned}$ |  | - | 5 | $\mu \mathrm{A}$ |
| Icc4 | Vcc Current (Standby, Reset) | Vcc = Vcc Max.,$\text { RESET }=\mathrm{Vss} \pm 0.3 \mathrm{~V}$ |  | - | 5 | $\mu \mathrm{A}$ |
| Icc5 | Vcc Current (Automatic Sleep Mode) (Note 3) | $\mathrm{V}_{\mathrm{cc}}=\mathrm{V}_{\mathrm{cc}}$ Max., $\overline{\mathrm{CE}}=\mathrm{V}_{\mathrm{ss}} \pm 0.3 \mathrm{~V}$, <br> RESET $=\mathrm{Vcc} \pm 0.3 \mathrm{~V}$ <br> $\mathrm{V}_{\mathrm{IN}}=\mathrm{V} \mathrm{cc} \pm 0.3 \mathrm{~V}$ or $\mathrm{V}_{\mathrm{ss}} \pm 0.3 \mathrm{~V}$ |  | - | 5 | $\mu \mathrm{A}$ |
| Icc6 | Vcc Active Current (Note 5) (Read-While-Program) | $\overline{\mathrm{CE}}=\mathrm{V}_{\mathrm{IL}}, \overline{\mathrm{OE}}=\mathrm{V}_{\mathrm{H}}$ | Byte | - | 45 | mA |
|  |  |  | Word | - | 45 |  |
| 1 lc 7 | Vcc Active Current (Note 5) (Read-While-Erase) | $\overline{\mathrm{CE}}=\mathrm{V}_{\mathrm{IL}}, \overline{\mathrm{OE}}=\mathrm{V}_{\mathrm{H}}$ | Byte | - | 45 | mA |
|  |  |  | Word | - | 45 |  |
| Icc8 | Vcc Active Current <br> (Erase-Suspend-Program) | $\overline{\mathrm{CE}}=\mathrm{V}_{\mathrm{IL}}, \overline{\mathrm{OE}}=\mathrm{V}_{\mathrm{H}}$ |  | - | 35 | mA |
| VIL | Input Low Level | - |  | -0.5 | 0.6 | V |
| $\mathrm{V}_{\mathrm{H}}$ | Input High Level | - |  | 2.0 | V cc+0.3 | V |
| VID | Voltage for Autoselect and Sector Protection ( $\left.\mathrm{A}_{9}, \overline{\mathrm{OE}}, \mathrm{RESET}\right)$ (Note 4) | - |  | 11.5 | 12.5 | V |
| VoL | Output Low Voltage Level | $\mathrm{loL}=4.0 \mathrm{~mA}, \mathrm{~V}_{\mathrm{cc}}=\mathrm{V}_{\mathrm{cc}} \mathrm{Min}$. |  | - | 0.45 | V |
| Vory | Output High Voltage Level | $\mathrm{Ioh}^{\prime}=-2.0 \mathrm{~mA}, \mathrm{~V}_{\mathrm{cc}}=\mathrm{V}_{\mathrm{cc}} \mathrm{Min}$. |  | 2.4 | - | V |
| Vон2 |  | $\mathrm{loH}=-100 \mu \mathrm{~A}$ |  | Vcc-0.4 | - | V |
| Vıко | Low Vcc Lock-Out Voltage | - |  | 2.3 | 2.5 | V |

Notes: 1. The Icc current listed includes both the DC operating current and the frequency dependent component.
2. Icc active while Embedded Algorithm (program or erase) is in progress.
3. Automatic sleep mode enables the low power mode when address remain stable for 150 ns .
4. Applicable for only $\mathrm{V}_{\mathrm{cc}}$ applying.
5. Embedded Algorithm (program or erase) is in progress. (@5 MHz)

## MBM29DL400TC-55/-70-90/-12/MBM29DL400BC-55/-70-90/-12

## AC CHARACTERISTICS

- Read Only Operations Characteristics

| Parameter Symbols |  | Description | Test Setup |  | $\begin{gathered} -55 \\ \text { (Note) } \end{gathered}$ | $\begin{gathered} -70 \\ \text { (Note) } \end{gathered}$ | $\left(\begin{array}{l} -90 \\ \text { (Note }) \end{array}\right.$ | $\begin{gathered} -12 \\ \text { (Note) } \end{gathered}$ | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| JEDEC | Standard |  |  |  |  |  |  |  |  |
| tavav | trc | Read Cycle Time | - | Min. | 55 | 70 | 90 | 120 | ns |
| tavav | tacc | Address to Output Delay | $\begin{aligned} & \overline{\overline{C E}}=V_{I L} \\ & \overline{O E}=V_{I L} \end{aligned}$ | Max. | 55 | 70 | 90 | 120 | ns |
| telov | tce | Chip Enable to Output Delay | $\overline{\mathrm{OE}}=\mathrm{V}$ IL | Max. | 55 | 70 | 90 | 120 | ns |
| tglav | toe | Output Enable to Output Delay | - | Max. | 30 | 30 | 35 | 50 | ns |
| tehaz | tof | Chip Enable to Output High-Z | - | Max. | 25 | 25 | 30 | 30 | ns |
| tghaz | tof | Output Enable to Output High-Z | - | Max. | 25 | 25 | 30 | 30 | ns |
| taxax | tor | Output Hold Time From Addresses, $\overline{\mathrm{CE}}$ or $\overline{\mathrm{OE}}$, Whichever Occurs First | - | Min. | 0 | 0 | 0 | 0 | ns |
| - | tready | RESET Pin Low to Read Mode | - | Max. | 20 | 20 | 20 | 20 | $\mu \mathrm{s}$ |
| - | $\begin{aligned} & \text { tELFL } \\ & \text { tELFH } \end{aligned}$ |  | - | Max. | 5 | 5 | 5 | 5 | ns |

Note: Test Conditions:
Output Load: 1 TTL gate and 30 pF (MBM29DL400TC/BC-55/-70)
1 TTL gate and 100 pF (MBM29DL400TC/BC-90/-12)
Input rise and fall times: 5 ns
Input pulse levels: 0.0 V to 3.0 V
Timing measurement reference level
Input: 1.5 V
Output:1.5 V


Note: $\mathrm{CL}=30 \mathrm{pF}$ including jig capacitance (MBM29DL400TC/BC-55/-70)
$C L=100 \mathrm{pF}$ including jig capacitance (MBM29DL400TC/BC-90/-12)
Figure 4 Test Conditions

## MBM29DL400TC-55/-70-90/-12/MBM29DL400BC-55/-70/-90/-12

- Write/Erase/Program Operations

| Parameter Symbols |  | Description |  |  | MBM29DL400TC/BC |  |  |  | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| JEDEC | Standard |  |  |  | -55 | -70 | -90 | -12 |  |
| tavav | twc | Write Cycle Time |  | Min. | 55 | 70 | 90 | 120 | ns |
| tavwL | tas | Address Setup Time |  | Min. | 0 | 0 | 0 | 0 | ns |
| - | taso | Address Setup Time to $\overline{\mathrm{OE}}$ Low During Toggle Bit Polling |  | Min. | 15 | 15 | 15 | 15 | ns |
| twlax | tar | Address Hold Time |  | Min. | 45 | 45 | 45 | 50 | ns |
| - | tАнт | Address Hold Time from $\overline{\mathrm{CE}}$ or $\overline{\mathrm{OE}}$ High During Toggle Bit Polling |  | Min. | 0 | 0 | 0 | 0 | ns |
| tovw | tos | Data Setup Time |  | Min. | 30 | 35 | 45 | 50 | ns |
| twhox | toh | Data Hold Time |  | Min. | 0 | 0 | 0 | 0 | ns |
| - | tоен | Output Enable Hold Time | Read | Min. | 0 | 0 | 0 | 0 | ns |
|  |  |  | Toggle and Data Polling | Min. | 10 | 10 | 10 | 10 | ns |
| - | tcepr | $\overline{\mathrm{CE}}$ High During Toggle Bit Polling |  | Min. | 20 | 20 | 20 | 25 | ns |
| - | toeph | $\overline{\mathrm{OE}}$ High During Toggle Bit Polling |  | Min. | 20 | 20 | 20 | 25 | ns |
| tghwL | tghwi | Read Recover Time Before Write |  | Min. | 0 | 0 | 0 | 0 | ns |
| tghel | tghel | Read Recover Time Before Write |  | Min. | 0 | 0 | 0 | 0 | ns |
| telw | tcs | $\overline{\text { CE Setup Time }}$ |  | Min. | 0 | 0 | 0 | 0 | ns |
| twLel | tws | $\overline{\text { WE Setup Time }}$ |  | Min. | 0 | 0 | 0 | 0 | ns |
| twher | tch | $\overline{\text { CE Hold Time }}$ |  | Min. | 0 | 0 | 0 | 0 | ns |
| tehwh | twh | $\overline{\text { WE Hold Time }}$ |  | Min. | 0 | 0 | 0 | 0 | ns |
| twLwh | twp | Write Pulse Width |  | Min. | 30 | 35 | 45 | 50 | ns |
| teLeh | tcp | $\overline{\text { CE Pulse Width }}$ |  | Min. | 30 | 35 | 45 | 50 | ns |
| twhwL | twpH | Write Pulse Width High |  | Min. | 25 | 25 | 25 | 30 | ns |
| tehel | tcPH | CE Pulse Width High |  | Min. | 25 | 25 | 25 | 30 | ns |
| twhwht | twhwh1 | Byte Programming Operation |  | Typ. | 8 | 8 | 8 | 8 | $\mu \mathrm{s}$ |
| twHWHz | twhwhz | Sector Erase Operation (Note 1) |  | Typ. | 1 | 1 | 1 | 1 | sec |
| - | tvcs | Vcc Setup Time |  | Min. | 50 | 50 | 50 | 50 | $\mu \mathrm{s}$ |
| - | tvior | Rise Time to VID (Note 2) |  | Min. | 500 | 500 | 500 | 500 | ns |
| - | tviht | Voltage Transition Time (Note 2) |  | Min. | 4 | 4 | 4 | 4 | $\mu \mathrm{s}$ |
| - | twpp | Write Pulse Width (Note 2) |  | Min. | 100 | 100 | 100 | 100 | $\mu \mathrm{s}$ |
| - | toesp | $\overline{\text { OE Setup Time to WE Active (Note 2) }}$ |  | Min. | 4 | 4 | 4 | 4 | $\mu \mathrm{s}$ |

(Continued)

## MBM29DL400TC-55/-70/-90/-12/MBM29DL400BC-55/-70-90/-12

(Continued)

| Parameter Symbols |  | Description |  | MBM29DL400TC/BC |  |  |  | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| JEDEC | Standard |  |  | -55 | -70 | -90 | -12 |  |
| - | tcsp | CE Setup Time to WE Active (Note 2) | Min. | 4 | 4 | 4 | 4 | $\mu \mathrm{s}$ |
| - | $t_{\text {RB }}$ | Recover Time From RY/ $\overline{B Y}$ | Min. | 0 | 0 | 0 | 0 | ns |
| - | trp | RESET Pulse Width | Min. | 500 | 500 | 500 | 500 | ns |
| - | trh | RESET Hold Time Before Read | Min. | 200 | 200 | 200 | 200 | ns |
| - | trlaz |  | Max. | 30 | 30 | 35 | 50 | ns |
| - | tFhov | $\overline{\text { BYTE Switching High to Output Active }}$ | Min. | 30 | 30 | 35 | 50 | ns |
| - | tbusy | Program/Erase Valid to RY/ $\overline{B Y}$ Delay | Max. | 90 | 90 | 90 | 90 | ns |
| - | teoe | Delay Time from Embedded Output Enable | Max. | 30 | 30 | 35 | 50 | ns |

Notes: 1. This does not include the preprogramming time.
2. This timing is for Sector Protection operation.

## MBM29DL400TC-55/-70/-90/-12/MBM29DL400BC-55/-70/-90/-12

## SWITCHING WAVEFORMS

## - Key to Switching Waveforms

| WAVEFORM | OUTPUTS <br>  <br> Must Be <br> Steady |
| :--- | :--- |
| May <br> Change <br> Steady <br> from H to L | Will Be <br> Changing <br> from H to L |
|  | May <br> Change <br> from L to H |
| Will Be <br> Changing <br> from L to H |  |
| "H" or "L" |  |
| Any Change |  |
| Permitted |  |$\quad$| Changing |
| :--- |
| State |
| Unknown |



Figure 5.1 AC Waveforms for Read Operations

## MBM29DL400TC-55/-70/-90/-12/MBM29DL400BC-55/-70/-90/-12



Figure 5.2 AC Waveforms for Hardware Reset/Read Operations

## MBM29DL400TC-55/-70/-90/-12/MBM29DL400BC-55/-70/-90/-12



Notes: 1. PA is address of the memory location to be programmed.
2. PD is data to be programmed at byte address.
3. $\overline{\mathrm{DQ}}_{7}$ is the output of the complement of the data written to the device.
4. Dout is the output of the data written to the device.
5. Figure indicates last two bus cycles out of four bus cycle sequence.

6 . These waveforms are for the $\times 16$ mode. (The addresses differ from $\times 8$ mode.)

Figure 6 Alternate $\overline{\text { WE Controlled Program Operations }}$

## MBM29DL400TC. 55 -70-900-12/MBM29DL400BC. $55 /-70-90-12$



Notes: 1. PA is address of the memory location to be programmed.
2. PD is data to be programmed at byte address.
3. $\overline{\mathrm{DQ}}_{7}$ is the output of the complement of the data written to the device.
4. Dout is the output of the data written to the device.
5. Figure indicates last two bus cycles out of four bus cycle sequence.
6. These waveforms are for the $\times 16$ mode. (The addresses differ from $\times 8$ mode.)

Figure 7 Alternate $\overline{\mathbf{C E}}$ Controlled Program Operations

## MBM29DL400TC-55/-70-90/-12/MBM29DL400BC-55/-70/-90/-12



Notes: 1. SA is the sector address for Sector Erase. Addresses $=555 \mathrm{H}$ (Word), AAAH (Byte) for Chip Erase.
2. These waveforms are for the $\times 16$ mode. (The addresses differ from $\times 8$ mode.)

Figure 8 AC Waveforms Chip/Sector Erase Operations

## MBM29DL400TC-55/-70-90/-12/MBM29DL400BC-55/-70-90/-12



* $: \mathrm{DQ}_{7}=$ Valid Data (The device has completed the Embedded operation).

Figure 9 AC Waveforms for $\overline{\text { Data }}$ Polling during Embedded Algorithm Operations

## MBM29DL400TC-55/-70-90/-12/MBM29DL400BC-55/-70-90/-12


*: DQ6 stops toggling (The device has completed the Embedded operation).
Figure 10 AC Waveforms for Toggle Bit I during Embedded Algorithm Operations


Figure $12 \overline{\mathrm{RESET}} / \mathrm{RY} / \overline{\mathrm{BY}}$ Timing Diagram

## MBM29DL400TC-55/-70/-90/-12/MBM29DL400BC-55/-70/-90/-12



Figure 13 Timing Diagram for Word Mode Configuration


Figure 14 Timing Diagram for Byte Mode Configuration


Figure 15 BYTE Timing Diagram for Write Operations


SAX : Sector Address for initial sector
SAY : Sector Address for next sector
Note: A-1 is VIL on byte mode.

Figure 16 AC Waveforms for Sector Protection

## MBM29DL400TC-55/-70-90/-12/MBM29DL400BC-55/-70/-90/-12



Note: This is example of Read for Bank 1 and Embedded Algorithm (program) for Bank 2.
BA1: Address of Bank 1.
BA2: Address of Bank 2.
Figure 18 Back-to-back Read/Write Timing Diagram

## MBM29DL400TC-55/-70/-90/-12/MBM29DL400BC-55/-70/-90/-12



Note: $\mathrm{DQ}_{2}$ is read from the erase-suspended sector.

Figure $19 \mathrm{DQ}_{2}$ vs. DQ6

## MBM29DL400TC-55/-70/-90/-12/MBM29DL400BC-55/-70/-90/-12



SPAX : Sector Address to be protected
SPAY : Next Sector Address to be protected
TIME-OUT : Time-Out window $=150 \mu \mathrm{~s}(\mathrm{~min})$

Figure 20 Extended Sector Protection Timing Diagram

## MBM29DL400TC-55/-70-90/-12/MBM29DL400BC-55/-70-90/-12

## EMBEDDED ALGORITHMS



Program Command Sequence* (Address/Command):

*: The sequence is applied for $\times 16$ mode.
The addresses differ from $\times 8$ mode.

Figure 21 Embedded Program ${ }^{\text {TM }}$ Algorithm

## MBM29DL400TC-55/-70/-90/-12/MBM29DL400BC-55/-70/-90/-12

## EMBEDDED ALGORITHMS



* : The sequence is applied for $\times 16$ mode. The addresses differ from $\times 8$ mode.

Figure 22 Embedded Erase ${ }^{\text {TM }}$ Algorithm

## MBM29DL400TC-55/-70-90/-12/MBM29DL400BC-55/-70-90/-12


$\mathrm{VA}=$ Byte address for programming
= Any of the sector addresses within the sector being erased during sector erase or multiple sector erases operation
= Any of the sector addresses within the sector not being protected during chip erase

Note: $\mathrm{DQ}_{7}$ is rechecked even if $\mathrm{DQ}_{5}=$ " 1 " because $\mathrm{DQ}_{7}$ may change simultaneously with DQ5.

Figure 23 Data Polling Algorithm

## MBM29DL400TC-55/-70/-90/-12/MBM29DL400BC-55/-70-90/-12



Note: $\mathrm{DQ}_{6}$ is rechecked even if $\mathrm{DQ}_{5}=$ " 1 " because $\mathrm{DQ}_{6}$ may stop toggling at the same time as DQ5 changing to " 1 ".

Figure 24 Toggle Bit Algorithm


* : A-1 is VIL on byte mode.

Figure 25 Sector Protection Algorithm

## MBM29DL400TC-55/-70/-90/-12/MBM29DL400BC-55/-70/-90/-12



Notes: 1. All protected sectors are unprotected.
2. All previously protected sectors are protected once again.

Figure 26 Temporary Sector Unprotection Algorithm


## MBM29DL400TC-55/-70/-90/-12/MBM29DL400BC-55/-70/-90/-12

## FAST MODE ALGORITHM


*:The sequence is applied for $\times 16$ mode. The addresses differ from $\times 8$ mode.

Figure 28 Embedded Program ${ }^{\text {TM }}$ Algorithm for Fast Mode

## MBM29DL400TC. $55 /-70-90-12 /$ /MBM29DL400BC. $55-70 \cdot-90-12$

## ERASE AND PROGRAMMING PERFORMANCE

| Parameter | Limits |  |  | Unit | Comments |
| :---: | :---: | :---: | :---: | :---: | :---: |
|  | Min. | Typ. | Max. |  |  |
| Sector Erase Time | - | 1 | 10 | sec | Excludes programming time prior to erasure |
| Word Programming Time | - | 16 | 360 | $\mu \mathrm{s}$ | Excludes system-level overhead |
| Byte Programming Time | - | 8 | 300 | $\mu \mathrm{S}$ |  |
| Chip Programming Time | - | 4.2 | 12.5 | sec | Excludes system-level overhead |
| Program/Erase Cycle | 100,000 | - | - | cycles | - |

## TSOP(I) PIN CAPACITANCE

| Parameter <br> Symbol | Parameter Description | Test Setup | Typ. | Max. | Unit |
| :--- | :--- | :--- | :---: | :---: | :---: |
| $\mathrm{C}_{\mathbb{N}}$ | Input Capacitance | $\mathrm{V}_{\mathbb{N}=0}$ | 6 | 7.5 | pF |
| $\mathrm{Cout}^{\mathrm{N}} \mathrm{O}$ | Output Capacitance | $\mathrm{V}_{\mathrm{OU}}=0$ | 8.5 | 12 | pF |
| $\mathrm{C}_{\mathbb{N} 2}$ | Control Pin Capacitance | $\mathrm{V}_{\mathbb{N}=0}$ | 8 | 10 | pF |

Note: Test conditions $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}, \mathrm{f}=1.0 \mathrm{MHz}$

## To Top / Lineup / Index

## MBM29DL400TC-55/-70/-90/-12/MBM29DL400BC-55/-70-90/-12

## PACKAGE DIMENSIONS



48-pin plastic TSOP(I)

* : Resin protrusion. (Each Side: 0.15 (.006)max)
(FPT-48P-M20)



## FUJITSU LIMITED

## For further information please contact:

## Japan

FUJITSU LIMITED
Corporate Global Business Support Division
Electronic Devices
KAWASAKI PLANT, 4-1-1, Kamikodanaka
Nakahara-ku, Kawasaki-shi
Kanagawa 211-8588, Japan
Tel: 81(44) 754-3763
Fax: 81(44) 754-3329
http://www.fujitsu.co.jp/
North and South America
FUJITSU MICROELECTRONICS, INC.
Semiconductor Division
3545 North First Street
San Jose, CA 95134-1804, USA
Tel: (408) 922-9000
Fax: (408) 922-9179
Customer Response Center
Mon. - Fri.: 7 am-5 pm (PST)
Tel: (800) 866-8608
Fax: (408) 922-9179
http://www.fujitsumicro.com/
Europe
FUJITSU MIKROELEKTRONIK GmbH
Am Siebenstein 6-10
D-63303 Dreieich-Buchschlag
Germany
Tel: (06103) 690-0
Fax: (06103) 690-122
http://www.fujitsu-ede.com/
Asia Pacific
FUJITSU MICROELECTRONICS ASIA PTE LTD
\#05-08, 151 Lorong Chuan
New Tech Park
Singapore 556741
Tel: (65) 281-0770
Fax: (65) 281-0220
http://www.fmap.com.sg/

All Rights Reserved.
The contents of this document are subject to change without notice. Customers are advised to consult with FUJITSU sales representatives before ordering.

The information and circuit diagrams in this document are presented as examples of semiconductor device applications, and are not intended to be incorporated in devices for actual use. Also, FUJITSU is unable to assume responsibility for infringement of any patent rights or other rights of third parties arising from the use of this information or circuit diagrams.

FUJITSU semiconductor devices are intended for use in standard applications (computers, office automation and other office equipment, industrial, communications, and measurement equipment, personal or household devices, etc.).
CAUTION:
Customers considering the use of our products in special applications where failure or abnormal operation may directly affect human lives or cause physical injury or property damage, or where extremely high levels of reliability are demanded (such as aerospace systems, atomic energy controls, sea floor repeaters, vehicle operating controls, medical devices for life support, etc.) are requested to consult with FUJITSU sales representatives before such use. The company will not be responsible for damages arising from such use without prior approval.

Any semiconductor devices have an inhereut chance of failure. You must protect against injury, damage or loss from such failures by incorporating safety design measures into your facility and equipment such as redundancy, fire protection, and prevention of over-current levels and other abnormal operating conditions.

If any products described in this document represent goods or technologies subject to certain restrictions on export under the Foreign Exchange and Foreign Trade Law of Japan, the prior authorization by Japanese government will be required for export of those products from Japan.

